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United States Patent Application Publication

20250257087

Kind Code

A1

Publication Date

August 14, 2025

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ORGANIC ELECTROLUMINESCENT MATERIALS AND DEVICES

Abstract

A compound comprising a first ligand L.sub.A of Formula I,

##STR00001##

is provided. In Formula I, moiety C is a monocyclic ring or fused polycyclic system; each of X.sup.1 to X.sup.6 is C or N; K is a direct bond or a linker; at least one of R.sup.B or R.sup.C has the formula -L-SiR.sub.1R.sub.2R.sub.3, or -L-GeR.sub.1R.sub.2R.sub.3; L is a direct bond or an organic linker; each R.sup.α, R.sup.β, R.sub.1, R.sub.2, R.sub.3, R.sup.A, R.sup.B, and R.sup.C is hydrogen or a General Substituent defined herein; L.sub.A is coordinated to a metal M by the dashed lines in Formula I; and M has an atomic mass of at least 40 and may be coordinated to other ligands. Formulations, OLEDs, and consumer products containing the compound are also provided.

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Appl. No.: 18/632072

Filed: April 10, 2024

Related U.S. Application Data

parent US continuation-in-part 18480100 20231003 PENDING child US 18632072

parent US continuation-in-part 18347793 20230706 PENDING child US 18480100

parent US continuation-in-part 17959326 20221004 PENDING child US 18347793

us-provisional-application US 63386980 20221212

us-provisional-application US 63392385 20220726

Publication Classification

Int. Cl.: C07F15/00 (20060101); C09K11/06 (20060101); H10K50/11 (20230101); H10K85/30 (20230101)

U.S. Cl.:

CPC C07F15/0033 (20130101); C07F15/0086 (20130101); C09K11/06 (20130101); H10K50/11 (20230201); H10K85/342 (20230201); H10K85/346 (20230201); C09K2211/185 (20130101)

Background/Summary

CROSS-REFERENCE TO RELATED APPLICATIONS [0001] This application is a continuation-in-part of co-pending U.S. patent application Ser. No. 18/480,100, filed on Oct. 3, 2023, which is a continuation-in-part of co-pending U.S. patent application Ser. No. 18/347,793, filed on Jul. 6, 2023, which (i) is a continuation-in-part of co-pending U.S. patent application Ser. No. 17/959,326, filed on Oct. 4, 2022, (ii) claims priority under 35 U.S.C. § 119(e) to U.S. Provisional Application No. 63/392,385, filed on Jul. 26, 2022, and (iii) claims priority under 35 U.S.C. § 119(e) to U.S. Provisional Application No. 63/386,980, filed on Dec. 12, 2022, the entire contents of all the above referenced applications are incorporated herein by reference.

FIELD

[0002] The present disclosure generally relates to organometallic compounds and formulations and their various uses including as emitters in devices such as organic light emitting diodes and related electronic devices.

BACKGROUND

[0003] Opto-electronic devices that make use of organic materials are becoming increasingly desirable for various reasons. Many of the materials used to make such devices are relatively inexpensive, so organic opto-electronic devices have the potential for cost advantages over inorganic devices. In addition, the inherent properties of organic materials, such as their flexibility, may make them well suited for particular applications such as fabrication on a flexible substrate. Examples of organic opto-electronic devices include organic light emitting diodes/devices (OLEDs), organic phototransistors, organic photovoltaic cells, and organic photodetectors. For OLEDs, the organic materials may have performance advantages over conventional materials. [0004] OLEDs make use of thin organic films that emit light when voltage is applied across the device. OLEDs are becoming an increasingly interesting technology for use in applications such as flat panel displays, illumination, and backlighting.

[0005] One application for phosphorescent emissive molecules is a full color display. Industry standards for such a display call for pixels adapted to emit particular colors, referred to as “saturated” colors. In particular, these standards call for saturated red, green, and blue pixels. Alternatively, the OLED can be designed to emit white light. In conventional liquid crystal displays emission from a white backlight is filtered using absorption filters to produce red, green and blue emission. The same technique can also be used with OLEDs. The white OLED can be either a single emissive layer (EML) device or a stack structure. Color may be measured using CIE coordinates, which are well known to the art.

SUMMARY

[0006] Disclosed are novel metal complexes with silyl groups, that can be used as emissive dopant in OLED device to improve performance.

[0007] In one aspect, the present disclosure provides a compound comprising a first ligand L.sub.A of Formula I,
##STR00002##
In Formula I:
[0008] moiety C is a monocyclic ring or fused polycyclic system, where the monocyclic ring and each ring of the fused polycyclic system is independently a 5-membered and 6-membered carbocyclic or heterocyclic ring; [0009] each of X.sup.1 to X.sup.6 is independently C or N; [0010] K is selected from the group consisting of a direct bond, O, S, N(R.sup.α), P(R.sup.α), B(R.sup.α), C(R.sup.α)(R.sup.β), and Si(R.sup.α)(R.sup.β); [0011] at least one of R.sup.B or R.sup.C has the formula -L-SiR.sub.1R.sub.2R.sub.3, or -L-GeR.sub.1R.sub.2R.sub.3; [0012] L is a direct bond or an organic linker; [0013] R.sup.A, R.sup.B, and R.sup.C each independently represents mono to the maximum allowable substitution, or no substitution; [0014] each R.sup.α, R.sup.β, R.sub.1, R.sub.2, R.sub.3, R.sup.A, R.sup.B, and R.sup.C is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; [0015] any two substituents may be joined or fused to form a ring except where they are excluded; [0016] L.sub.A is coordinated to a metal M by the dashed lines in Formula I; [0017] M has an atomic mass of at least 40 and may be coordinated to other ligands; and [0018] L.sub.A can be joined with other ligands to comprise a tridentate, tetradentate, pentadentate, or hexadentate ligand, [0019] with a proviso that if M is Ir and K is a direct bond, and moiety C is a benzene ring, then at least one of the following statements is true: [0020] (1) at least one of X.sup.1 to X.sup.6 is N; [0021] (2) L is not a direct bond; [0022] (3) two R.sup.A substituents do not join to form a ring; [0023] (4) two R.sup.A substituents are joined together to form a structure of Formula II fused to ring A, Formula II has the structure

##STR00003##

wherein: [0024] Y.sup.1 is selected from the group consisting of BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO.sub.2, CR, CRR', SiRR', GeRR'; [0025] Y.sup.2 is CR.sup.1' or N; [0026] each R, R', R.sup.1, R.sup.1', R.sup.2, and R.sup.3 is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; and [0027] if Y.sup.2 is CR.sup.1', then R is not a cyclic group or R and R.sup.1' are joined together to form a fused ring.

[0028] In another aspect, the present disclosure provides a formulation comprising a compound comprising a first ligand L.sub.A of Formula I as described herein.

[0029] In yet another aspect, the present disclosure provides an OLED having an organic layer comprising a compound comprising a first ligand L.sub.A of Formula I as described herein.

[0030] In yet another aspect, the present disclosure provides a consumer product comprising an OLED with an organic layer comprising a compound comprising a first ligand L.sub.A of Formula I as described herein.

Description

BRIEF DESCRIPTION OF THE DRAWINGS

[0031] FIG. 1 shows an organic light emitting device.

[0032] FIG. 2 shows an inverted organic light emitting device that does not have a separate

electron transport layer.

DETAILED DESCRIPTION

A. Terminology

[0033] Unless otherwise specified, the below terms used herein are defined as follows:

[0034] As used herein, the term “organic” includes polymeric materials as well as small molecule organic materials that may be used to fabricate organic opto-electronic devices. “Small molecule” refers to any organic material that is not a polymer, and “small molecules” may actually be quite large. Small molecules may include repeat units in some circumstances. For example, using a long chain alkyl group as a substituent does not remove a molecule from the “small molecule” class. Small molecules may also be incorporated into polymers, for example as a pendent group on a polymer backbone or as a part of the backbone. Small molecules may also serve as the core moiety of a dendrimer, which consists of a series of chemical shells built on the core moiety. The core moiety of a dendrimer may be a fluorescent or phosphorescent small molecule emitter. A dendrimer may be a “small molecule,” and it is believed that all dendrimers currently used in the field of OLEDs are small molecules.

[0035] As used herein, “top” means furthest away from the substrate, while “bottom” means closest to the substrate. Where a first layer is described as “disposed over” a second layer, the first layer is disposed further away from substrate. There may be other layers between the first and second layer, unless it is specified that the first layer is “in contact with” the second layer. For example, a cathode may be described as “disposed over” an anode, even though there are various organic layers in between.

[0036] As used herein, “solution processable” means capable of being dissolved, dispersed, or transported in and/or deposited from a liquid medium, either in solution or suspension form.

[0037] A ligand may be referred to as “photoactive” when it is believed that the ligand directly contributes to the photoactive properties of an emissive material. A ligand may be referred to as “ancillary” when it is believed that the ligand does not contribute to the photoactive properties of an emissive material, although an ancillary ligand may alter the properties of a photoactive ligand.

[0038] As used herein, and as would be generally understood by one skilled in the art, a first “Highest Occupied Molecular Orbital” (HOMO) or “Lowest Unoccupied Molecular Orbital” (LUMO) energy level is “greater than” or “higher than” a second HOMO or LUMO energy level if the first energy level is closer to the vacuum energy level. Since ionization potentials (IP) are measured as a negative energy relative to a vacuum level, a higher HOMO energy level corresponds to an IP having a smaller absolute value (an IP that is less negative). Similarly, a higher LUMO energy level corresponds to an electron affinity (EA) having a smaller absolute value (an EA that is less negative). On a conventional energy level diagram, with the vacuum level at the top, the LUMO energy level of a material is higher than the HOMO energy level of the same material. A “higher” HOMO or LUMO energy level appears closer to the top of such a diagram than a “lower” HOMO or LUMO energy level.

[0039] As used herein, and as would be generally understood by one skilled in the art, a first work function is “greater than” or “higher than” a second work function if the first work function has a higher absolute value. Because work functions are generally measured as negative numbers relative to vacuum level, this means that a “higher” work function is more negative. On a conventional energy level diagram, with the vacuum level at the top, a “higher” work function is illustrated as further away from the vacuum level in the downward direction. Thus, the definitions of HOMO and LUMO energy levels follow a different convention than work functions.

[0040] The terms “halo,” “halogen,” and “halide” are used interchangeably and refer to fluorine, chlorine, bromine, and iodine.

[0041] The term “acyl” refers to a substituted carbonyl radical (C(O)—R.sub.s).

[0042] The term “ester” refers to a substituted oxycarbonyl (—O—C(O)—R.sub.s or —C(O)—O—R.sub.s) radical.

[0043] The term “ether” refers to an —OR, radical.

[0044] The terms “sulfanyl” or “thio-ether” are used interchangeably and refer to a —SR, radical.

[0045] The term “selenyl” refers to a —SeR.sub.s radical.

[0046] The term “sulfinyl” refers to a —S(O)—R.sub.s radical.

[0047] The term “sulfonyl” refers to a —SO.sub.2—R.sub.s radical.

[0048] The term “phosphino” refers to a —P(R.sub.s).sub.3 radical, wherein each R, can be same or different.

[0049] The term “silyl” refers to a —Si(R.sub.s).sub.3 radical, wherein each R, can be same or different.

[0050] The term “germyl” refers to a —Ge(R.sub.s).sub.3 radical, wherein each R, can be same or different.

[0051] The term “boryl” refers to a —B(R.sub.s).sub.2 radical or its Lewis adduct —B(R.sub.s).sub.3 radical, wherein R, can be same or different.

[0052] In each of the above, R, can be hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, and combination thereof. Preferred R, is selected from the group consisting of alkyl, cycloalkyl, aryl, heteroaryl, and combination thereof.

[0053] The term “alkyl” refers to and includes both straight and branched chain alkyl radicals. Preferred alkyl groups are those containing from one to fifteen carbon atoms and includes methyl, ethyl, propyl, 1-methylethyl, butyl, 1-methylpropyl, 2-methylpropyl, pentyl, 1-methylbutyl, 2-methylbutyl, 3-methylbutyl, 1,1-dimethylpropyl, 1,2-dimethylpropyl, 2,2-dimethylpropyl, and the like. Additionally, the alkyl group may be optionally substituted.

[0054] The term “cycloalkyl” refers to and includes monocyclic, polycyclic, and spiro alkyl radicals. Preferred cycloalkyl groups are those containing 3 to 12 ring carbon atoms and includes cyclopropyl, cyclopentyl, cyclohexyl, bicyclo[3.1.1]heptyl, spiro[4.5]decyl, spiro[5.5]undecyl, adamantyl, and the like. Additionally, the cycloalkyl group may be optionally substituted.

[0055] The terms “heteroalkyl” or “heterocycloalkyl” refer to an alkyl or a cycloalkyl radical, respectively, having at least one carbon atom replaced by a heteroatom. Optionally the at least one heteroatom is selected from O, S, N, P, B, Si and Se, preferably, O, S or N. Additionally, the heteroalkyl or heterocycloalkyl group may be optionally substituted.

[0056] The term “alkenyl” refers to and includes both straight and branched chain alkene radicals. Alkenyl groups are essentially alkyl groups that include at least one carbon-carbon double bond in the alkyl chain. Cycloalkenyl groups are essentially cycloalkyl groups that include at least one carbon-carbon double bond in the cycloalkyl ring. The term “heteroalkenyl” as used herein refers to an alkenyl radical having at least one carbon atom replaced by a heteroatom. Optionally the at least one heteroatom is selected from O, S, N, P, B, Si, and Se, preferably, O, S, or N. Preferred alkenyl, cycloalkenyl, or heteroalkenyl groups are those containing two to fifteen carbon atoms. Additionally, the alkenyl, cycloalkenyl, or heteroalkenyl group may be optionally substituted.

[0057] The term “alkynyl” refers to and includes both straight and branched chain alkyne radicals. Alkynyl groups are essentially alkyl groups that include at least one carbon-carbon triple bond in the alkyl chain. Preferred alkynyl groups are those containing two to fifteen carbon atoms. Additionally, the alkynyl group may be optionally substituted.

[0058] The terms “aralkyl” or “arylalkyl” are used interchangeably and refer to an alkyl group that is substituted with an aryl group. Additionally, the aralkyl group may be optionally substituted.

[0059] The term “heterocyclic group” refers to and includes aromatic and non-aromatic cyclic radicals containing at least one heteroatom. Optionally the at least one heteroatom is selected from O, S, N, P, B, Si, and Se, preferably, O, S, or N. Hetero-aromatic cyclic radicals may be used interchangeably with heteroaryl. Preferred hetero-non-aromatic cyclic groups are those containing 3 to 7 ring atoms which includes at least one hetero atom, and includes cyclic amines such as

morpholino, piperidino, pyrrolidino, and the like, and cyclic ethers/thio-ethers, such as tetrahydrofuran, tetrahydropyran, tetrahydrothiophene, and the like. Additionally, the heterocyclic group may be optionally substituted.

[0060] The term “aryl” refers to and includes both single-ring aromatic hydrocarbonyl groups and polycyclic aromatic ring systems. The polycyclic rings may have two or more rings in which two carbons are common to two adjoining rings (the rings are “fused”) wherein at least one of the rings is an aromatic hydrocarbonyl group, e.g., the other rings can be cycloalkyls, cycloalkenyls, aryl, heterocycles, and/or heteroaryl. Preferred aryl groups are those containing six to thirty carbon atoms, preferably six to twenty carbon atoms, more preferably six to twelve carbon atoms. Especially preferred is an aryl group having six carbons, ten carbons or twelve carbons. Suitable aryl groups include phenyl, biphenyl, triphenyl, triphenylene, tetraphenylene, naphthalene, anthracene, phenalene, phenanthrene, fluorene, pyrene, chrysene, perylene, and azulene, preferably phenyl, biphenyl, triphenyl, triphenylene, fluorene, and naphthalene. Additionally, the aryl group may be optionally substituted.

[0061] The term “heteroaryl” refers to and includes both single-ring aromatic groups and polycyclic aromatic ring systems that include at least one heteroatom. The heteroatoms include, but are not limited to O, S, N, P, B, Si, and Se. In many instances, O, S, or N are the preferred heteroatoms. Hetero-single ring aromatic systems are preferably single rings with 5 or 6 ring atoms, and the ring can have from one to six heteroatoms. The hetero-polycyclic ring systems can have two or more rings in which two atoms are common to two adjoining rings (the rings are “fused”) wherein at least one of the rings is a heteroaryl, e.g., the other rings can be cycloalkyls, cycloalkenyls, aryl, heterocycles, and/or heteroaryl. The hetero-polycyclic aromatic ring systems can have from one to six heteroatoms per ring of the polycyclic aromatic ring system. Preferred heteroaryl groups are those containing three to thirty carbon atoms, preferably three to twenty carbon atoms, more preferably three to twelve carbon atoms. Suitable heteroaryl groups include dibenzothiophene, dibenzofuran, dibenzoselenophene, furan, thiophene, benzofuran, benzothiophene, benzoselenophene, carbazole, indolocarbazole, pyridylindole, pyrrolodipyridine, pyrazole, imidazole, triazole, oxazole, thiazole, oxadiazole, oxatriazole, dioxazole, thiadiazole, pyridine, pyridazine, pyrimidine, pyrazine, triazine, oxazine, oxathiazine, oxadiazine, indole, benzimidazole, indazole, indoxazine, benzoxazole, benzisoxazole, benzothiazole, quinoline, isoquinoline, cinnoline, quinazoline, quinoxaline, naphthyridine, phthalazine, pteridine, xanthene, acridine, phenazine, phenothiazine, phenoxazine, benzofuropyridine, furodipyridine, benzothienopyridine, thienodipyridine, benzoselenophenopyridine, and selenophenodipyridine, preferably dibenzothiophene, dibenzofuran, dibenzoselenophene, carbazole, indolocarbazole, imidazole, pyridine, triazine, benzimidazole, 1,2-azaborine, 1,3-azaborine, 1,4-azaborine, borazine, and aza-analogs thereof. Additionally, the heteroaryl group may be optionally substituted.

[0062] Of the aryl and heteroaryl groups listed above, the groups of triphenylene, naphthalene, anthracene, dibenzothiophene, dibenzofuran, dibenzoselenophene, carbazole, indolocarbazole, imidazole, pyridine, pyrazine, pyrimidine, triazine, and benzimidazole, and the respective aza-analogs of each thereof are of particular interest.

[0063] The terms alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aralkyl, heterocyclic group, aryl, and heteroaryl, as used herein, are independently unsubstituted, or independently substituted, with one or more General Substituents.

[0064] In many instances, the General Substituents are selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, boryl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, selenyl, sulfinyl, sulfonyl, phosphino, and combinations thereof.

[0065] In some instances, the Preferred General Substituents are selected from the group consisting of deuterium, fluorine, alkyl, cycloalkyl, heteroalkyl, alkoxy, aryloxy, amino, silyl, germyl, boryl,

alkenyl, cycloalkenyl, heteroalkenyl, aryl, heteroaryl, nitrile, isonitrile, sulfanyl, and combinations thereof.

[0066] In some instances, the More Preferred General Substituents are selected from the group consisting of deuterium, fluorine, alkyl, cycloalkyl, alkoxy, aryloxy, amino, silyl, aryl, heteroaryl, sulfanyl, and combinations thereof.

[0067] In yet other instances, the Most Preferred General Substituents are selected from the group consisting of deuterium, fluorine, alkyl, cycloalkyl, aryl, heteroaryl, and combinations thereof.

[0068] The terms “substituted” and “substitution” refer to a substituent other than H that is bonded to the relevant position, e.g., a carbon or nitrogen. For example, when R^{sup.1} represents mono-substitution, then one R^{sup.1} must be other than H (i.e., a substitution). Similarly, when R^{sup.1} represents di-substitution, then two of R^{sup.1} must be other than H. Similarly, when R^{sup.1} represents zero or no substitution, R^{sup.1}, for example, can be a hydrogen for available valencies of ring atoms, as in carbon atoms for benzene and the nitrogen atom in pyrrole, or simply represents nothing for ring atoms with fully filled valencies, e.g., the nitrogen atom in pyridine. The maximum number of substitutions possible in a ring structure will depend on the total number of available valencies in the ring atoms.

[0069] As used herein, “combinations thereof” indicates that one or more members of the applicable list are combined to form a known or chemically stable arrangement that one of ordinary skill in the art can envision from the applicable list. For example, an alkyl and deuterium can be combined to form a partial or fully deuterated alkyl group; a halogen and alkyl can be combined to form a halogenated alkyl substituent; and a halogen, alkyl, and aryl can be combined to form a halogenated arylalkyl. In one instance, the term substitution includes a combination of two to four of the listed groups. In another instance, the term substitution includes a combination of two to three groups. In yet another instance, the term substitution includes a combination of two groups. Preferred combinations of substituent groups are those that contain up to fifty atoms that are not hydrogen or deuterium, or those which include up to forty atoms that are not hydrogen or deuterium, or those that include up to thirty atoms that are not hydrogen or deuterium. In many instances, a preferred combination of substituent groups will include up to twenty atoms that are not hydrogen or deuterium.

[0070] The “aza” designation in the fragments described herein, i.e. aza-dibenzofuran, aza-dibenzothiophene, etc. means that one or more of the C—H groups in the respective aromatic ring can be replaced by a nitrogen atom, for example, and without any limitation, azatriphenylene encompasses both dibenzo[f,h]quinoxaline and dibenzo[f,h]quinoline. One of ordinary skill in the art can readily envision other nitrogen analogs of the aza-derivatives described above, and all such analogs are intended to be encompassed by the terms as set forth herein.

[0071] As used herein, “deuterium” refers to an isotope of hydrogen. Deuterated compounds can be readily prepared using methods known in the art. For example, U.S. Pat. No. 8,557,400, Patent Pub. No. WO 2006/095951, and U.S. Pat. Application Pub. No. US 2011/0037057, which are hereby incorporated by reference in their entireties, describe the making of deuterium-substituted organometallic complexes. Further reference is made to Ming Yan, et al., *Tetrahedron* 2015, 71, 1425-30 and Atzrodt et al., *Angew. Chem. Int. Ed. (Reviews)* 2007, 46, 7744-65, which are incorporated by reference in their entireties, describe the deuteration of the methylene hydrogens in benzyl amines and efficient pathways to replace aromatic ring hydrogens with deuterium, respectively.

[0072] It is to be understood that when a molecular fragment is described as being a substituent or otherwise attached to another moiety, its name may be written as if it were a fragment (e.g. phenyl, phenylene, naphthyl, dibenzofuryl) or as if it were the whole molecule (e.g. benzene, naphthalene, dibenzofuran). As used herein, these different ways of designating a substituent or attached fragment are considered to be equivalent.

[0073] In some instances, a pair of adjacent substituents can be optionally joined or fused into a

ring. The preferred ring is a five, six, or seven-membered carbocyclic or heterocyclic ring, includes both instances where the portion of the ring formed by the pair of substituents is saturated and where the portion of the ring formed by the pair of substituents is unsaturated. As used herein, "adjacent" means that the two substituents involved can be on the same ring next to each other, or on two neighboring rings having the two closest available substitutable positions, such as 2, 2' positions in a biphenyl, or 1, 8 position in a naphthalene, as long as they can form a stable fused ring system.

B. The Compounds of the Present Disclosure

[0074] In one aspect, the present disclosure provides a compound comprising a first ligand L.sub.A of Formula I,

##STR00004##

In Formula I:

[0075] moiety C is a monocyclic ring or fused polycyclic system, where the monocyclic ring and each ring of the fused polycyclic system is independently a 5-membered and 6-membered carbocyclic or heterocyclic ring;

[0076] each of X.sup.1 to X.sup.6 is independently C or N;

[0077] K is selected from the group consisting of a direct bond, O, S, N(R.sup.α), P(R.sup.α), B(R.sup.α), C(R.sup.α)(R.sup.β), and Si(R.sup.α)(R.sup.β);

[0078] at least one of R.sup.B or R.sup.C has the formula -L-SiR.sub.1R.sub.2R.sub.3, or -L-GeR.sub.1R.sub.2R.sub.3;

[0079] L is a direct bond or an organic linker;

[0080] R.sup.A, R.sup.B, and R.sup.C each independently represent mono to the maximum allowable substitution, or no substitution;

[0081] each R.sup.α, R.sup.β, R.sub.1, R.sub.2, R.sub.3, R.sup.A, R.sup.B, and R.sup.C is independently hydrogen or a substituent selected from the group consisting of the General Substituents defined herein;

[0082] any two substituents may be joined or fused to form a ring except where they are excluded to form a ring;

[0083] L.sub.A is coordinated to a metal M by the dashed lines in Formula I;

[0084] M has an atomic mass of at least 40 and may be coordinated to other ligands; and

[0085] L.sub.A can be joined with other ligands to comprise a tridentate, tetradentate, pentadentate, or hexadentate ligand.

[0086] In some embodiments of Formula I, R.sup.A and R.sup.B do not join to form a ring.

[0087] In some embodiments, if M is Ir and K is a direct bond, and moiety C is a benzene ring, at least one of X.sup.1 to X.sup.6 is N.

[0088] In some embodiments, if M is Ir and K is a direct bond, and moiety C is a benzene ring, L is not a direct bond.

[0089] In some embodiments, if M is Ir and K is a direct bond, and moiety C is a benzene ring, two R.sup.A substituents do not join to form a ring.

In some embodiments, if M is Ir and K is a direct bond, and moiety C is a benzene ring two R.sup.A substituents are joined together to form a structure of Formula II fused to ring A, wherein Formula II has the structure

##STR00005##

wherein:

[0090] Y.sup.1 is selected from the group consisting of BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO.sub.2, CR, CRR', SiRR', GeRR';

[0091] Y.sup.2 is CR.sup.1' or N;

each R, R' R.sup.1, R.sup.1', and R.sup.2 is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl,

heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; and
[0092] if Y^{sup.2} is CR^{sup.1'}, then R is not a cyclic group or R and R' are joined together to form a fused ring.

[0093] In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R^{sub.C} is partially or fully deuterated. In some embodiments, at least one R^{sup.A} is partially or fully deuterated. In some embodiments, at least one R^{sup.B} is partially or fully deuterated. In some embodiments, at least one R^{sub.C} is partially or fully deuterated.

[0094] In some embodiments, each R, R', R^{sup.α}, R^{sup.β}, R^{sub.1}, R^{sub.2}, R^{sub.3}, R^{sup.A}, R^{sup.B}, and R^{sup.C} is independently hydrogen or a substituent selected from the group consisting of the Preferred General Substituents defined herein. In some embodiments, each R, R', R^{sup.α}, R^{sup.β}, R^{sub.1}, R^{sub.2}, R^{sub.3}, R^{sup.A}, R^{sup.B}, and R^{sup.C} is independently hydrogen or a substituent selected from the group consisting of the More Preferred General Substituents defined herein. In some embodiments, each R, R', R^{sup.α}, R^{sup.β}, R^{sub.1}, R^{sub.2}, R^{sub.3}, R^{sup.A}, R^{sup.B}, and R^{sup.C} is independently hydrogen or a substituent selected from the group consisting of the Most Preferred General Substituents defined herein.

[0095] In some embodiments, each of X^{sup.1} to X^{sup.4} is C. In some embodiments, each of X^{sup.5} to X^{sup.6} is C. In some embodiments, each of X^{sup.1} to X^{sup.6} is C.

[0096] In some embodiments, at least one of X^{sup.1} to X^{sup.6} is N. In some embodiments, at least one of X^{sup.1} to X^{sup.4} is N. In some embodiments, at least one of X^{sup.5} to X^{sup.6} is N.

[0097] In some embodiments, no two substituents R^{sup.A} form a ring.

[0098] In some embodiments, at least one R^{sup.A} is not hydrogen. In some embodiments, at least one R^{sup.A} is not hydrogen and deuterium.

[0099] In some embodiments, at least one R^{sup.A} is selected from the group consisting of alkyl, cycloalkyl, aryl, heteroaryl, partially or fully deuterated variants thereof, partially or fully fluorinated variants thereof, and combinations thereof.

[0100] In some embodiments, two R^{sup.A} are joined or fused together to form an aromatic moiety fused to ring A.

[0101] In some such embodiments, the aromatic moiety fused to ring A is selected from the group consisting benzene, pyridine, pyrimidine, pyridazine, pyrazine, triazine, imidazole, pyrazole, pyrrole, oxazole, furan, thiophene, thiazole, triazole, naphthalene, quinoline, isoquinoline, quinazoline, benzofuran, aza-benzofuran, benzoxazole, aza-benzoxazole, benzothiophene, aza-benzothiophene, benzothiazole, aza-benzothiazole, benzoselenophene, aza-benzoselenophene, indene, aza-indene, indole, aza-indole, benzimidazole, aza-benzimidazole, carbazole, aza-carbazole, dibenzofuran, aza-dibenzofuran, dibenzothiophene, aza-dibenzothiophene, quinoxaline, phthalazine, phenanthrene, aza-phenanthrene, anthracene, aza-anthracene, phenanthridine, fluorene, and aza-fluorene

[0102] In some embodiments, the aza variant includes one N on a benzo ring. In some embodiments, the aza variant includes one N on a benzo ring and the N is bonded to the metal M.

[0103] In some embodiments, two R^{sup.A} substituents are joined together to form a structure of Formula II fused to ring A.

[0104] In some embodiments including Formula II, Y^{sup.1} is bonded to X^{sup.4} and Y^{sup.2} is bonded to X^{sup.3}.

[0105] In some embodiments including Formula II, Y^{sup.2} is bonded to X^{sup.4} and Y^{sup.1} is bonded to X^{sup.3}.

[0106] In some embodiments including Formula II, Y^{sup.1} is bonded to X^{sup.3} and Y^{sup.2} is bonded to X^{sup.2}.

[0107] In some embodiments including Formula II, Y^{sup.2} is bonded to X^{sup.2} and Y^{sup.1} is bonded to X^{sup.3}.

[0108] In some embodiments including Formula II, Y^{sup.1} is bonded to X^{sup.2} and Y^{sup.2} is

bonded to X.sup.1.

[0109] In some embodiments including Formula II, Y.sup.2 is bonded to X.sup.1 and Y.sup.1 is bonded to X.sup.2.

[0110] In some embodiments including Formula II, Y.sup.1 is O, Se, or S.

[0111] In some embodiments including Formula II, Y.sup.1 is NR.

[0112] In some embodiments including Formula II, Y.sup.1 is CR.sup.1R.sup.2 or SiR.sup.1R.sup.2.

[0113] In some embodiments including Formula II, Y.sup.2 is CR.sup.1'. In some such embodiments, R.sup.1' is joined with R to form a fused ring. In some such embodiments, the fused ring is selected from the group consisting of benzene, pyridine, pyrimidine, pyridazine, pyrazine, imidazole, pyrazole, pyrrole, oxazole, furan, thiophene, thiazole, and triazole. In some such embodiments, the fused ring is phenyl. In some such embodiments, the fused ring is pyridine. In some such embodiments, the fused ring is further substituted by alkyl, cycloalkyl, aryl, partially fluorinated variants thereof, and combinations thereof.

[0114] In some embodiments including Formula II, R is not a cyclic group. In some embodiments including Formula II, R is not hydrogen.

[0115] In some embodiments, K is a direct bond.

[0116] In some embodiments, K is O or S. In some embodiments, K is O. In some embodiments, K is S.

[0117] In some embodiments, K is N(R.sup.α), P(R.sup.α), or B(R.sup.α).

[0118] In some embodiments, K is C(R.sup.α)(R.sup.β), or Si(R.sup.α)(R.sup.β);

[0119] In some embodiments, at least one R.sup.B is not hydrogen. In some embodiments, at least one R.sup.B is not hydrogen or deuterium.

[0120] In some embodiments, at least one R.sub.C is not hydrogen. In some embodiments, at least one R.sub.C is not hydrogen or deuterium.

[0121] In some embodiments, at least one R.sup.B has the formula -L-SiR.sub.1R.sub.2R.sub.3. In some embodiments, R.sup.B at X.sup.5 has the formula -L-SiR.sub.1R.sub.2R.sub.3. In some embodiments, R.sup.B at X.sup.6 has the formula -L-SiR.sub.1R.sub.2R.sub.3.

[0122] In some embodiments, at least one R.sub.C has the formula -L-SiR.sub.1R.sub.2R.sub.3. In some embodiments, R.sub.C at X.sup.5 has the formula -L-SiR.sub.1R.sub.2R.sub.3. In some embodiments, R.sub.C at X.sup.6 has the formula -L-SiR.sub.1R.sub.2R.sub.3.

[0123] In some embodiments, at least one R.sup.B has the formula -L-GeR.sub.1R.sub.2R.sub.3. In some embodiments, R.sup.B at X.sup.5 has the formula -L-GeR.sub.1R.sub.2R.sub.3. In some embodiments, R.sup.B at X.sup.6 has the formula -L-GeR.sub.1R.sub.2R.sub.3.

[0124] In some embodiments, at least one R.sub.C has the formula -L-GeR.sub.1R.sub.2R.sub.3. In some embodiments, R.sub.C at X.sup.5 has the formula -L-GeR.sub.1R.sub.2R.sub.3. In some embodiments, R.sub.C at X.sup.6 has the formula -L-GeR.sub.1R.sub.2R.sub.3.

[0125] In some embodiments, L is a direct bond.

[0126] In some embodiments, L is an organic linker selected from the group consisting of BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR', C=CR'R'', S=O, SO.sub.2, CR, CRR', SiRR', GeRR', alkylene, cycloalkyl, aryl, cycloalkylene, arylene, heteroarylene, and combinations thereof, where each R, R', and R'' is independently a hydrogen or selected from the group consisting of the General Substituents defined herein; and any two substituents may be joined or fused to form a ring.

[0127] In some embodiments, L is alkyl, cycloalkyl, aryl, heteroaryl, or combinations thereof. In some embodiments, L is benzene. In some embodiments, L is alkylene. In some embodiments, L is methylene.

[0128] In some embodiments, at least one of R.sub.1, R.sub.2, and R.sub.3 is other than hydrogen. In some embodiments, at least one of R.sub.1, R.sub.2, and R.sub.3 is alkyl or cycloalkyl. In some embodiments, at least one of R.sub.1, R.sub.2, and R.sub.3 is aryl. In some embodiments, each of

R.sub.1, R.sub.2, and R.sub.3 is other than hydrogen. In some embodiments, each of R.sub.1, R.sub.2, and R.sub.3 is alkyl, aryl, or a combination thereof.

[0129] In some embodiments, at least two of R.sub.1, R.sub.2, and R.sub.3 are other than hydrogen or deuterium.

[0130] In some embodiments, at least one of R.sub.1, R.sub.2, and R.sub.3 is joined with L to form a ring. In some such embodiments, the ring is saturated. In some such embodiments, the ring is unsaturated. In some such embodiments, the ring is a six-membered ring. In some such embodiments, the ring comprises two Si atoms. In some such embodiments, the ring is further substituted.

[0131] In some embodiments, two of R.sub.1, R.sub.2, and R.sub.3 are joined together to form a ring. In some such embodiments the ring is saturated. In some such embodiments, the ring is unsaturated. In some such embodiments, the ring is a six-membered ring. In some such embodiments, the ring is further substituted.

[0132] In some embodiments, each of R.sub.1, R.sub.2, and R.sub.3 is independently selected from the group consisting of alkyl, cycloalkyl, aryl, heteroaryl, silyl, and combinations thereof.

[0133] In some embodiments, each of R.sub.1, R.sub.2, and R.sub.3 is independently selected from the group consisting of phenyl, methyl, ethyl, propyl, 1-methylethyl, butyl, 1-methylpropyl, 2-methylpropyl, pentyl, 1-methylbutyl, 2-methylbutyl, 3-methylbutyl, 1,1-dimethylpropyl, 1,2-dimethylpropyl, 2,2-dimethylpropyl, cyclopentyl, cyclohexyl, and partially or fully deuterated variants thereof.

[0134] In some embodiments, the formula -L-SiR.sub.1R.sub.2R.sub.3 or the formula -L-GeR.sub.1R.sub.2R.sub.3 may be selected from the group consisting of the following structures:
##STR00006## ##STR00007## ##STR00008## ##STR00009## ##STR00010## ##STR00011##

[0135] In some embodiments, the formula -L-SiR.sub.1R.sub.2R.sub.3 or the formula -L-GeR.sub.1R.sub.2R.sub.3 may be selected from the group consisting of the following structures:
##STR00012## ##STR00013## ##STR00014## ##STR00015## ##STR00016## ##STR00017##
##STR00018## ##STR00019## ##STR00020## ##STR00021## ##STR00022## ##STR00023##
##STR00024## ##STR00025## ##STR00026## ##STR00027## ##STR00028## ##STR00029##
##STR00030## ##STR00031## ##STR00032## ##STR00033## ##STR00034##

[0136] In some embodiments, moiety C is selected from the group consisting of benzene, pyridine, pyrimidine, pyridazine, pyrazine, triazine, imidazole, pyrazole, pyrrole, oxazole, furan, thiophene, thiazole, naphthalene, quinoline, isoquinoline, quinazoline, benzofuran, aza-benzofuran, benzoxazole, aza-benzoxazole, benzothiophene, aza-benzothiophene, benzothiazole, aza-benzothiazole, benzoselenophene, aza-benzoselenophene, indene, aza-indene, indole, aza-indole, benzimidazole, aza-benzimidazole, carbazole, aza-carbazole, dibenzofuran, aza-dibenzofuran, dibenzothiophene, aza-dibenzothiophene, quinoxaline, phthalazine, phenanthrene, aza-phenanthrene, anthracene, aza-anthracene, phenanthridine, fluorene, and aza-fluorene. In some embodiments, moiety C is phenyl.

[0137] As used herein, “moiety A” refers to a polycyclic fused ring system formed by ring A and two or more R.sup.A that are joined to form a ring or ring system fused to ring A. As used herein, “moiety B1” refers to the combination of ring B and moiety C, as well as any ring or ring system formed by R.sup.B that is fused to ring B.

[0138] In some embodiments, each of moiety A and moiety B1 can independently be a polycyclic fused ring structure. In some embodiments, each of moiety A and moiety B1 can independently be a polycyclic fused ring structure comprising at least three fused rings. In some embodiments, the polycyclic fused ring structure has two 6-membered rings and one 5-membered ring. In some such embodiments, the 5-membered ring is fused to the ring coordinated to metal M and the second 6-membered ring is fused to the 5-membered ring. In some embodiments, each of moiety A and moiety B1 can independently be selected from the group consisting of dibenzofuran, dibenzothiophene, dibenzoselenophene, and aza-variants thereof. In some such embodiments, each

of moiety A and moiety B1 can independently be further substituted at the ortho- or meta-position of the O, S, or Se atom by a substituent selected from the group consisting of deuterium, fluorine, nitrile, alkyl, cycloalkyl, aryl, heteroaryl, and combinations thereof. In some such embodiments, the aza-variants contain exactly one N atom at the 6-position (ortho to the O, S, or Se) with a substituent at the 7-position (meta to the O, S, or Se).

[0139] In some embodiments, each of moiety A and moiety B1 can independently be a polycyclic fused ring structure comprising at least four fused rings. In some embodiments, the polycyclic fused ring structure comprises three 6-membered rings and one 5-membered ring. In some such embodiments, the 5-membered ring is fused to the ring coordinated to metal M, the second 6-membered ring is fused to the 5-membered ring, and the third 6-membered ring is fused to the second 6-membered ring. In some such embodiments, the third 6-membered ring is further substituted by a substituent selected from the group consisting of deuterium, fluorine, nitrile, alkyl, cycloalkyl, aryl, heteroaryl, and combinations thereof.

[0140] In some embodiments, each of moiety A and moiety B1 can independently be a polycyclic fused ring structure comprising at least five fused rings. In some embodiments, the polycyclic fused ring structure comprises four 6-membered rings and one 5-membered ring or three 6-membered rings and two 5-membered rings. In some embodiments comprising two 5-membered rings, the 5-membered rings are fused together. In some embodiments comprising two 5-membered rings, the 5-membered rings are separated by at least one 6-membered ring. In some embodiments with one 5-membered ring, the 5-membered ring is fused to the ring coordinated to metal M, the second 6-membered ring is fused to the 5-membered ring, the third 6-membered ring is fused to the second 6-membered ring, and the fourth 6-membered ring is fused to the third 6-membered ring.

[0141] In some embodiments, each moiety A and moiety B1 can independently be an aza version of the polycyclic fused rings described above. In some such embodiments, each moiety A and moiety B1 can independently contain exactly one aza N atom. In some such embodiments, each moiety A and moiety B1 can contain exactly two aza N atoms, which can be in one ring, or in two different rings. In some such embodiments, the ring having aza N atom is separated by at least two other rings from the metal M atom. In some such embodiments, the ring having aza N atom is separated by at least three other rings from the metal M atom. In some such embodiments, each of the ortho position of the aza N atom is substituted.

[0142] In some embodiments, M is selected from the group consisting of Ir, Rh, Re, Ru, Os, Pt, Pd, Ag, Au, and Cu. In some embodiments, M is Ir. In some embodiments, M is Pt.

[0143] In some embodiments, Formula I comprises an electron-withdrawing group. In these embodiments, the electron-withdrawing group commonly comprises one or more highly electronegative elements including but not limited to fluorine, oxygen, sulfur, nitrogen, chlorine, and bromine.

[0144] In some embodiments, the electron-withdrawing group has a Hammett constant larger than 0. In some embodiments, the electron-withdrawing group has a Hammett constant equal or larger than 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, or 1.1.

[0145] In some embodiments, the electron-withdrawn group is selected from the group consisting of the structures of the following LIST EWG 1: F, CF.sub.3, CN, COCH.sub.3, CHO, COCF.sub.3, COOMe, COOCF.sub.3, NO.sub.2, SF.sub.3, SiF.sub.3, PF.sub.4, SF.sub.5, OCF.sub.3, SCF.sub.3, SeCF.sub.3, SOCF.sub.3, SeOCF.sub.3, SO.sub.2F, SO.sub.2CF.sub.3, SeO.sub.2CF.sub.3, OSeO.sub.2CF.sub.3, OCN, SCN, SeCN, NC, .sup.+N(R.sup.k2).sub.3, (R.sup.k2).sub.2CCN, (R.sup.k2).sub.2CCF.sub.3, CNC(CF.sub.3).sub.2, BR.sup.k3R.sup.k2, substituted or unsubstituted dibenzoborole, 1-substituted carbazole, 1,9-substituted carbazole, substituted or unsubstituted carbazole, substituted or unsubstituted pyridine, substituted or unsubstituted pyrimidine, substituted or unsubstituted pyrazine, substituted or unsubstituted pyridoxine, substituted or unsubstituted triazine, substituted or unsubstituted oxazole, substituted or unsubstituted benzoxazole, substituted or unsubstituted thiazole, substituted or unsubstituted benzothiazole, substituted or unsubstituted

imidazole, substituted or unsubstituted benzimidazole, ketone, carboxylic acid, ester, nitrile, isonitrile, sulfinyl, sulfonyl, partially and fully fluorinated alkyl, partially and fully fluorinated aryl, partially and fully fluorinated heteroaryl, cyano-containing alkyl, cyano-containing aryl, cyano-containing heteroaryl, isocyanate,

##STR00035## ##STR00036##

[0146] wherein Y^{sup.G} is selected from the group consisting of BR_{sub.e}, NR_{sub.e}, PR_{sub.e}, O, S, Se, C=O, S=O, SO_{sub.2}, CR_{sub.e}ER_{sub.f}, SiR_{sub.e}ER_{sub.f}, and GeR_{sub.e}ER_{sub.f}; and

[0147] R^{sup.k1} each independently represents mono to the maximum allowable substitutions, or no substitution;

[0148] wherein each of R^{sup.k}, R^{sup.k2}, R^{sup.k3}, R_{sub.e}, and R_{sub.f} is independently a hydrogen or a substituent selected from the group consisting of the General Substituents defined herein.

[0149] In some embodiments, the electron-withdrawing group is selected from the group consisting of the structures of the following LIST EWG 2:

##STR00037## ##STR00038## ##STR00039## ##STR00040## ##STR00041## ##STR00042##
##STR00043## ##STR00044## ##STR00045## ##STR00046## ##STR00047## ##STR00048##

[0150] In some embodiments, the electron-withdrawing group is selected from the group consisting of the structures of the following LIST EWG 3:

##STR00049## ##STR00050## ##STR00051## ##STR00052## ##STR00053## ##STR00054##
##STR00055## ##STR00056## ##STR00057## ##STR00058##

[0151] In some embodiments, the electron-withdrawing group is selected from the group consisting of the structures of the following LIST EWG 4:

##STR00059## ##STR00060##

[0152] In some embodiments, the electron-withdrawing group is a π -electron deficient electron-withdrawing group. In some embodiments, the π -electron deficient electron-withdrawing group is selected from the group consisting of the structures of the following LIST Pi-EWG: CN, COCH_{sub.3}, CHO, COCF_{sub.3}, COOMe, COOCF_{sub.3}, NO_{sub.2}, SF_{sub.3}, SiF_{sub.3}, PF_{sub.4}, SF_{sub.5}, OCF_{sub.3}, SCF_{sub.3}, SeCF_{sub.3}, SOCF_{sub.3}, SeOCF_{sub.3}, SO_{sub.2}F, SO_{sub.2}CF_{sub.3}, SeO_{sub.2}CF_{sub.3}, OSeO_{sub.2}CF_{sub.3}, OCN, SCN, SeCN, NC, ^{sup.}+N(R^{sup.k1})_{sub.3}, BR^{sup.k1}R^{sup.k2}, substituted or unsubstituted dibenzoborole, 1-substituted carbazole, 1,9-substituted carbazole, substituted or unsubstituted carbazole, substituted or unsubstituted pyridine, substituted or unsubstituted pyrimidine, substituted or unsubstituted pyrazine, substituted or unsubstituted pyridazine, substituted or unsubstituted triazine, substituted or unsubstituted oxazole, substituted or unsubstituted benzoxazole, substituted or unsubstituted thiazole, substituted or unsubstituted benzothiazole, substituted or unsubstituted imidazole, substituted or unsubstituted benzimidazole, ketone, carboxylic acid, ester, nitrile, isonitrile, sulfinyl, sulfonyl, partially and fully fluorinated aryl, partially and fully fluorinated heteroaryl, cyano-containing aryl, cyano-containing heteroaryl, isocyanate,

##STR00061## ##STR00062##

wherein the variables are the same as previously defined.

[0153] In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R^{sup.C} is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R^{sup.C} is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R_{sub.C} is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R_{sub.C} is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments of Formula I, at least one of R^{sup.A}, R^{sup.B}, or R_{sub.C} is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0154] In some embodiments of Formula I, at least one R^{sup.A} is/comprises an electron-

withdrawing group from LIST EWG 1 as defined herein. In some embodiments of Formula I, at least one of R.sup.A is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments of Formula I, at least one of R.sup.A is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments of Formula I, at least one of R.sup.A is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments of Formula I, at least one of R.sup.A is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0155] In some embodiments of Formula I, at least one R.sup.B is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments of Formula I, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments of Formula I, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments of Formula I, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments of Formula I, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0156] In some embodiments of Formula I, at least one R.sub.C is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments of Formula I, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments of Formula I, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments of Formula I, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments of Formula I, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0157] In some embodiments of the compound, the compound comprises at least an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments of the compound, the compound comprises at least an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments of the compound, the compound comprises at least an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments of the compound, the compound comprises at least an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments of the compound, the compound comprises at least an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0158] In some embodiments, ligand L.sub.A is selected from the group consisting of the structures of the following LIST 1:

##STR00063## ##STR00064## ##STR00065## ##STR00066##

wherein:

[0159] L' is selected from direct bond or BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR', C=CR'R'', S=O, SO.sub.2, CRR', SiRR', and GeRR';

[0160] W is selected from B, N, CR, SiR, GeR, or P;

[0161] each of X.sup.7 to X.sup.16 is independently C or N;

[0162] each of Y.sup.A1, Y.sup.A2, and Z.sub.1 is independently selected from the group consisting of BR.sub.e, BR.sub.eR.sub.f, NR.sub.e, PR.sub.e, P(O)R.sub.e, O, S, Se, C=O, C=S, C=Se, C=NR.sub.e, C=CR.sub.eR.sub.f, S=O, SO.sub.2, CR.sub.e, CR.sub.eR.sub.f, SiR.sub.eR.sub.f, and GeR.sub.eR.sub.f;

[0163] each R.sup.AA independently represents mono to the maximum allowable substitution, or no substitution;

[0164] each R.sub.e, R.sub.f, and R.sup.AA is independently hydrogen or a substituent selected from the group consisting of the General Substituents defined herein; and

[0165] any two substituents can be joined or fused to for a ring.

[0166] In some embodiments for the structures of LIST 1, at least one R.sup.AA, R.sup.B, or R.sub.C is partially or fully deuterated. In some embodiments, at least one R.sup.AA is partially or

fully deuterated. In some embodiments, at least one R.sup.B is partially or fully deuterated. In some embodiments, at least one R.sup.C is partially or fully deuterated.

[0167] In some embodiments for the structures of LIST 1, at least one R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.A is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0168] In some embodiments for the structures of LIST 1, at least one R.sup.B is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0169] In some embodiments for the structures of LIST 1, at least one R.sub.C is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sub.C is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.C is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0170] In some embodiments, the ligand L.sub.A is selected from the group consisting of the structures of the following LIST 2:

##STR00067## ##STR00068## ##STR00069## ##STR00070## ##STR00071## ##STR00072##
##STR00073## ##STR00074## ##STR00075## ##STR00076## ##STR00077##
##STR00078## ##STR00079## ##STR00080## ##STR00081## ##STR00082## ##STR00083##
##STR00084## ##STR00085## ##STR00086## ##STR00087##

[0171] each of Y.sup.A1, Y.sup.A2, and Y.sup.B1 is independently selected from the group consisting of BR, BR.sub.eR.sub.f, NR.sub.e, PR, P(O) R.sub.e, O, S, Se, C=O, C=S, C=Se, C=NR.sub.e, C=CR.sub.eR.sub.f, S=O, SO.sub.2, CR.sub.e, CR.sub.eR.sub.f, SiR.sub.eR.sub.f, and GeR.sub.eR.sub.f;

[0172] each R.sup.AA and R.sup.CC independently represents mono to the maximum allowable substitution, or no substitution;

[0173] each R.sup.AA, R.sup.CC, R.sub.e, and R.sub.f is independently hydrogen or a substituent selected from the group consisting of the General Substituents defined herein; and

[0174] any two substituents can be joined or fused to form a ring.

[0175] In some embodiments for the structures of LIST 2, at least one R.sup.AA, R.sup.B, or R.sup.CC is partially or fully deuterated. In some embodiments, at least one R.sup.AA is partially or fully deuterated. In some embodiments, at least one R.sup.B is partially or fully deuterated. In some embodiments, at least one R.sup.CC is partially or fully deuterated.

[0176] In some embodiments for the structures of LIST 2, at least one R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST Pi-EWG as defined

herein.

[0177] In some embodiments for the structures of LIST 1, at least one R.sup.B is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.






[0178] In some embodiments for the structures of LIST 1, at least one R.sup.CC is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.CC is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.CC is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.CC is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.CC is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0179] In some embodiments, the ligand L.sub.A is selected from the group consisting of the structures of the following LIST W:

##STR00088##














wherein L is selected from the group consisting of BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO.sub.2, CR, CRR', SiRR', and GeRR'; R, R' and all the remaining variables are the same as previously defined. In some embodiments, L is O, S, CRR', or SiRR'. In some embodiments, L is O or S. In some embodiments, Y.sup.B1 is O, S, or Se. In some embodiments, R.sup.AA is alkyl, cycloalkyl, aryl, heteroaryl, deuterium, F, silyl, germyl, or combinations thereof. In some embodiments, R.sup.B is alkyl, cycloalkyl, aryl, heteroaryl, deuterium, F, silyl, germyl, or combinations thereof. In some embodiments, R.sup.CC is alkyl, cycloalkyl, aryl, heteroaryl, deuterium, F, silyl, germyl, or combinations thereof.

[0180] In some embodiments, the ligand L.sub.A is selected from the group consisting of L.sub.A-i- (R.sup.EA)(R.sup.EB)(R.sup.EC) (R.sup.ED)(R.sup.H) and L.sub.A-i'-(R.sup.EA)(R.sup.EB) (R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H), wherein i is an integer from 1 to 12 and 19 to 24, i' is an integer from 13 to 18 or 25 to 40, each of R.sup.EA, R.sup.EB, R.sup.EC, R.sup.ED, and R.sup.EE is independently selected from the group consisting of R.sup.1 to R.sup.111, and R.sup.H is selected from the group consisting of R.sup.H1 to R.sup.H49, and wherein L.sub.A-1-(R.sup.1) (R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111) (R.sup.111)(R.sup.111)(R.sup.H49) are defined in the following LIST 3:













TABLE-US-00001 L.sub.A Structures of L.sub.A L.sub.A-1- (R.sup.EA)(R.sup.EB)(R.sup.EC) (R.sup.ED)(R.sup.H), wherein L.sub.A-1- (R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-1- (R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) have the structure [00089]  L.sub.A-2-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H), wherein L.sub.A-2- (R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-2- (R.sup.111)(R.sup.111) (R.sup.111) (R.sup.111)(R.sup.H49) have the structure [00090]  L.sub.A-3- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H), wherein L.sub.A-3- (R.sup.1)(R.sup.1) (R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-3- (R.sup.111)(R.sup.111)(R.sup.111) (R.sup.111) (R.sup.H49) have the structure [00091]  L.sub.A-4- (R.sup.EA)(R.sup.EB) (R.sup.EC)(R.sup.ED)(R.sup.H), wherein L.sub.A-4- (R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1) (R.sup.H1) to L.sub.A-4- (R.sup.111)(R.sup.111)(R.sup.111) (R.sup.111)(R.sup.H49) have the structure [00092]  L.sub.A-5- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED) (R.sup.H), wherein L.sub.A-5- (R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-5- (R.sup.111)(R.sup.111)(R.sup.111) (R.sup.111)(R.sup.H49) have the structure [00093]  L.sub.A-6- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H), wherein

[illegible]

[illegible]

(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) have the structure [00128]  [0181] wherein R.sup.H1 to R.sup.H49 are defined in the following LIST 4:
##STR00129## ##STR00130## ##STR00131## ##STR00132## ##STR00133## ##STR00134##
[0182] wherein R.sup.1 to R.sup.111 have the structures in the following LIST 5:
##STR00135## ##STR00136## ##STR00137## ##STR00138## ##STR00139## ##STR00140##
##STR00141## ##STR00142## ##STR00143## ##STR00144## ##STR00145##
[0183] In some embodiments, the ligand L.sub.A is selected from the group consisting of L.sub.A-w-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z) wherein w is an integer from 41 to 80, each of R.sup.EA, R.sup.EB, R.sup.EC, R.sup.ED, and R.sup.EE is independently selected from the group consisting of R.sub.1 to R.sub.337, and R.sub.Z is selected from the group consisting of R.sub.Z1 to R.sub.Z141; wherein each of L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144), are defined in the following LIST 3a:
TABLE-US-00002 L.sub.A Structures of L.sub.A L.sub.A-41- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-1- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-41- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00146]  L.sub.A-42-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-2- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-42- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00147]  L.sub.A-43- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-3- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-43- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00148]  L.sub.A-44- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-4- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-44- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00149]  L.sub.A-45- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-5- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-45- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00150]  L.sub.A-46- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-6- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-46- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00151]  L.sub.A-47- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-7- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-47- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00152]  L.sub.A-48- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-8- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-48- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00153]  L.sub.A-49- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-9- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-49- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00154]  L.sub.A-50- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-10- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-50- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00155]  L.sub.A-51- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-11- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-51- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00156]  L.sub.A-52- (R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z), wherein L.sub.A-12- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-52- (R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00157] 

[illegible]

(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-29- (R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)
(R.sub.1)(R.sub.Z1) to L.sub.A-69-(R.sub.337)(R.sub.337)(R.sub.337) (R.sub.337)(R.sub.337)
(R.sub.Z144) have the structure [00174]  L.sub.A-70- (R.sup.EA)(R.sup.EB)
(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-30- (R.sub.1)(R.sub.1)(R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-70-(R.sub.337)(R.sub.337)(R.sub.337) (R.sub.337)
(R.sub.337)(R.sub.Z144) have the structure [00175]  L.sub.A-71- (R.sup.EA)
(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-31- (R.sub.1)(R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-71-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00176]  L.sub.A-72-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-32- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-72-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00177]  L.sub.A-73-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-33- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-73-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00178]  L.sub.A-74-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-34- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-74-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00179]  L.sub.A-75-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-35- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-75-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00180]  L.sub.A-76-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-36- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-76-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00181]  L.sub.A-77-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-37- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-77-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00182]  L.sub.A-78-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-38- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-78-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00183]  L.sub.A-79-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-39- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-79-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00184]  L.sub.A-80-
(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE) (R.sub.Z), wherein L.sub.A-40- (R.sub.1)
(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)
(R.sub.337)(R.sub.337)(R.sub.Z144) have the structure [00185] 
wherein R.sub.Z1 to R.sub.Z144 have the structures defined below:

##STR00186## ##STR00187## ##STR00188## ##STR00189## ##STR00190## ##STR00191##
##STR00192## ##STR00193## ##STR00194## ##STR00195## ##STR00196## ##STR00197##
##STR00198## ##STR00199## ##STR00200## ##STR00201## ##STR00202## ##STR00203##
##STR00204## ##STR00205## ##STR00206## ##STR00207## ##STR00208## ##STR00209##
##STR00210## ##STR00211## ##STR00212##

wherein R.sub.1 to R.sub.337 have the structures in the following LIST 4a:

##STR00213## ##STR00214## ##STR00215## ##STR00216## ##STR00217## ##STR00218##
##STR00219## ##STR00220## ##STR00221## ##STR00222## ##STR00223## ##STR00224##
##STR00225## ##STR00226## ##STR00227## ##STR00228## ##STR00229## ##STR00230##
##STR00231## ##STR00232## ##STR00233## ##STR00234## ##STR00235## ##STR00236##
##STR00237## ##STR00238## ##STR00239## ##STR00240## ##STR00241##
##STR00242## ##STR00243## ##STR00244## ##STR00245## ##STR00246## ##STR00247##
##STR00248## ##STR00249## ##STR00250## ##STR00251## ##STR00252## ##STR00253##

##STR00254## ##STR00255## ##STR00256## ##STR00257## ##STR00258## ##STR00259##
##STR00260## ##STR00261## ##STR00262## ##STR00263## ##STR00264##

[0184] In some embodiments, the compound has a formula of $M(L_{\text{sub.A}})_{\text{sub.p}}(L_{\text{sub.B}})_{\text{sub.q}}(L_{\text{sub.C}})_{\text{sub.r}}$ wherein $L_{\text{sub.B}}$ and $L_{\text{sub.C}}$ are each a bidentate ligand; and wherein p is 1, 2, or 3; q is 0, 1, or 2; r is 0, 1, or 2; and $p+q+r$ is the oxidation state of the metal M .

[0185] In some embodiments, the compound has a formula selected from the group consisting of $Ir(L_{\text{sub.A}})_{\text{sub.3}}$, $Ir(L_{\text{sub.A}})(L_{\text{sub.B}})_{\text{sub.2}}$, $Ir(L_{\text{sub.A}})_{\text{sub.2}}(L_{\text{sub.B}})$, $Ir(L_{\text{sub.A}})_{\text{sub.2}}(L_{\text{sub.C}})$, and $Ir(L_{\text{sub.A}})(L_{\text{sub.B}})(L_{\text{sub.C}})$; and wherein $L_{\text{sub.A}}$, $L_{\text{sub.B}}$, and $L_{\text{sub.C}}$ are different from each other.

[0186] In some embodiments, $L_{\text{sub.B}}$ is a substituted or unsubstituted phenylpyridine, and $L_{\text{sub.C}}$ is a substituted or unsubstituted acetylacetonate.

[0187] In some embodiments, the compound has a formula of $Pt(L_{\text{sub.A}})(L_{\text{sub.B}})$; and wherein $L_{\text{sub.A}}$ and $L_{\text{sub.B}}$ can be same or different. In some such embodiments, $L_{\text{sub.A}}$ and $L_{\text{sub.B}}$ are connected to form a tetradentate ligand.

[0188] In some embodiments, $L_{\text{sub.B}}$ and $L_{\text{sub.C}}$ are each independently selected from the group consisting of the structures of the following LIST 6:

##STR00265## ##STR00266## ##STR00267## ##STR00268## ##STR00269##

[0189] wherein: [0190] T is selected from the group consisting of B, Al, Ga, and In; [0191] $K_{\text{sup.1'}}$ is selected from the group consisting of a single bond, O, S, $NR_{\text{sub.e}}$, $PR_{\text{sub.e}}$, $BR_{\text{sub.e}}$, $CR_{\text{sub.e}}$, $ER_{\text{sub.f}}$, and $SiR_{\text{sub.e}}$, $ER_{\text{sub.f}}$; [0192] each of $Y_{\text{sup.1}}$ to $Y_{\text{sup.13}}$ is independently selected from the group consisting of C and N; [0193] Y' is selected from the group consisting of $BR_{\text{sub.e}}$, $BR_{\text{sub.e}}$, $ER_{\text{sub.f}}$, $NR_{\text{sub.e}}$, $PR_{\text{sub.e}}$, $P(O)R_{\text{sub.e}}$, O, S, Se, $C=O$, $C=S$, $C=Se$, $C=NR_{\text{sub.e}}$, $C=CR_{\text{sub.e}}$, $ER_{\text{sub.f}}$, $S=O$, $SO_{\text{sub.2}}$, $CR_{\text{sub.e}}$, $ER_{\text{sub.f}}$, $SiR_{\text{sub.e}}$, $ER_{\text{sub.f}}$, and $GeR_{\text{sub.e}}$, $ER_{\text{sub.f}}$; [0194] $R_{\text{sub.e}}$ and $R_{\text{sub.f}}$ can be fused or joined to form a ring; [0195] each $R_{\text{sub.a}}$, $R_{\text{sub.b}}$, $R_{\text{sub.c}}$, and $R_{\text{sub.d}}$ independently represents from mono to the maximum allowed number of substitutions, or no substitution; [0196] each of $R_{\text{sub.a1}}$, $R_{\text{sub.b1}}$, $R_{\text{sub.c1}}$, $R_{\text{sub.d1}}$, $R_{\text{sub.a}}$, $R_{\text{sub.b}}$, $R_{\text{sub.c}}$, $R_{\text{sub.d}}$, $R_{\text{sub.e}}$, and $R_{\text{sub.f}}$ is independently a hydrogen or a substituent selected from the group consisting of the General Substituents defined herein; and any two substituents of $R_{\text{sub.a1}}$, $R_{\text{sub.b1}}$, $R_{\text{sub.c1}}$, $R_{\text{sub.d1}}$, $R_{\text{sub.a}}$, $R_{\text{sub.b}}$, $R_{\text{sub.c}}$, and $R_{\text{sub.d}}$ can be fused or joined to form a ring or form a multidentate ligand.

[0197] In some embodiments, $L_{\text{sub.B}}$ and $L_{\text{sub.C}}$ are each independently selected from the group consisting of the structures of the following LIST 7:

##STR00270## ##STR00271## ##STR00272## ##STR00273## ##STR00274## ##STR00275##
##STR00276## ##STR00277## ##STR00278## ##STR00279## ##STR00280## ##STR00281##
##STR00282## ##STR00283## ##STR00284## ##STR00285##

[0198] wherein:

[0199] $R_{\text{sub.a'}}$, $R_{\text{sub.b'}}$, $R_{\text{sub.c'}}$, $R_{\text{sub.d'}}$, and $R_{\text{sub.e'}}$ each independently represents zero, mono, or up to a maximum allowed number of substitution to its associated ring;

[0200] $R_{\text{sub.a'}}$, $R_{\text{sub.b'}}$, $R_{\text{sub.c'}}$, $R_{\text{sub.d'}}$, and $R_{\text{sub.e'}}$ each independently hydrogen or a substituent selected from the group consisting of the General Substituents defined herein; and

[0201] two substituents of $R_{\text{sub.a'}}$, $R_{\text{sub.b'}}$, $R_{\text{sub.c'}}$, $R_{\text{sub.d'}}$, and $R_{\text{sub.e'}}$ can be fused or joined to form a ring or form a multidentate ligand.

[0202] In some embodiments, the compound has formula $Ir(L_{\text{sub.A}})_{\text{sub.3}}$, formula $Ir(L_{\text{sub.A}})(L_{\text{sub.Bk}})_{\text{sub.2}}$, formula $Ir(L_{\text{sub.A}})_{\text{sub.2}}(L_{\text{sub.Bk}})$, formula $Ir(L_{\text{sub.A}})_{\text{sub.2}}(L_{\text{sub.Cj-I}})$, or formula $Ir(L_{\text{sub.A}})_{\text{sub.2}}(L_{\text{sub.Cj-II}})$,

[0203] wherein $L_{\text{sub.A}}$ is according to any $L_{\text{sub.A}}$ or Formula I as described herein including $L_{\text{sub.A-i}}(R_{\text{sup.EA}})(R_{\text{sup.EB}})(R_{\text{sup.EC}})(R_{\text{sup.ED}})(R_{\text{sup.H}})$, $-L_{\text{sub.A-i}}(R_{\text{sup.EA}})(R_{\text{sup.EB}})(R_{\text{sup.EC}})(R_{\text{sup.ED}})(R_{\text{sup.EE}})(R_{\text{sup.H}})$ and $L_{\text{sub.A-w}}(R_{\text{sup.EA}})(R_{\text{sup.EB}})(R_{\text{sup.EC}})(R_{\text{sup.ED}})(R_{\text{sup.EE}})(R_{\text{sub.Z}})$ as defined herein;

[0204] wherein k is an integer from 1 to 474, and each L.sub.Bk has the structure defined in the following LIST 8:

##STR00286## ##STR00287## ##STR00288## ##STR00289## ##STR00290## ##STR00291##
##STR00292## ##STR00293## ##STR00294## ##STR00295## ##STR00296## ##STR00297##
##STR00298## ##STR00299## ##STR00300## ##STR00301## ##STR00302## ##STR00303##
##STR00304## ##STR00305## ##STR00306## ##STR00307## ##STR00308## ##STR00309##
##STR00310## ##STR00311## ##STR00312## ##STR00313## ##STR00314## ##STR00315##
##STR00316## ##STR00317## ##STR00318## ##STR00319## ##STR00320## ##STR00321##
##STR00322## ##STR00323## ##STR00324## ##STR00325##
##STR00326## ##STR00327## ##STR00328## ##STR00329## ##STR00330## ##STR00331##
##STR00332## ##STR00333## ##STR00334## ##STR00335## ##STR00336## ##STR00337##
##STR00338## ##STR00339## ##STR00340## ##STR00341## ##STR00342## ##STR00343##
##STR00344## ##STR00345## ##STR00346## ##STR00347## ##STR00348## ##STR00349##
##STR00350## ##STR00351## ##STR00352## ##STR00353## ##STR00354## ##STR00355##
##STR00356## ##STR00357## ##STR00358## ##STR00359##
##STR00360## ##STR00361## ##STR00362## ##STR00363## ##STR00364## ##STR00365##
##STR00366## ##STR00367## ##STR00368## ##STR00369## ##STR00370## ##STR00371##
##STR00372## ##STR00373## ##STR00374## ##STR00375## ##STR00376## ##STR00377##
##STR00378## ##STR00379## ##STR00380## ##STR00381## ##STR00382## ##STR00383##
##STR00384## ##STR00385## ##STR00386## ##STR00387##

wherein each L.sub.Cj-I has a structure based on formula

##STR00388##

and

each L.sub.Cj-II has a structure based on formula

##STR00389##

wherein for each L.sub.Cj in L.sub.Cj-I and L.sub.Cj-II, R.sup.201 and R.sup.202 are each independently defined in the following LIST 9:

TABLE-US-00003 L.sub.Cj R.sup.201 R.sup.202 L.sub.Cj R.sup.201 R.sup.202 L.sub.Cj
R.sup.201 R.sup.202 L.sub.Cj R.sup.201 R.sup.202 L.sub.C1 R.sup.D1 R.sup.D1 L.sub.C193
R.sup.D1 R.sup.D3 L.sub.C385 R.sup.D17 R.sup.D40 L.sub.C577 R.sup.D143 R.sup.D120
L.sub.C2 R.sup.D2 R.sup.D2 L.sub.C194 R.sup.D1 R.sup.D4 L.sub.C386 R.sup.D17 R.sup.D41
L.sub.C578 R.sup.D143 R.sup.D133 L.sub.C3 R.sup.D3 R.sup.D3 L.sub.C195 R.sup.D1 R.sup.D5
L.sub.C387 R.sup.D17 R.sup.D42 L.sub.C579 R.sup.D143 R.sup.D134 L.sub.C4 R.sup.D4
R.sup.D4 L.sub.C196 R.sup.D1 R.sup.D9 L.sub.C388 R.sup.D17 R.sup.D43 L.sub.C580
R.sup.D143 R.sup.D135 L.sub.C5 R.sup.D5 R.sup.D5 L.sub.C197 R.sup.D1 R.sup.D10
L.sub.C389 R.sup.D17 R.sup.D48 L.sub.C581 R.sup.D143 R.sup.D136 L.sub.C6 R.sup.D6
R.sup.D6 L.sub.C198 R.sup.D1 R.sup.D17 L.sub.C390 R.sup.D17 R.sup.D49 L.sub.C582
R.sup.D143 R.sup.D144 L.sub.C7 R.sup.D7 R.sup.D7 L.sub.C199 R.sup.D1 R.sup.D18
L.sub.C391 R.sup.D17 R.sup.D50 L.sub.C583 R.sup.D143 R.sup.D145 L.sub.C8 R.sup.D8
R.sup.D8 L.sub.C200 R.sup.D1 R.sup.D20 L.sub.C392 R.sup.D17 R.sup.D54 L.sub.C584
R.sup.D143 R.sup.D146 L.sub.C9 R.sup.D9 R.sup.D9 L.sub.C201 R.sup.D1 R.sup.D22
L.sub.C393 R.sup.D17 R.sup.D55 L.sub.C585 R.sup.D143 R.sup.D147 L.sub.C10 R.sup.D10
R.sup.D10 L.sub.C202 R.sup.D1 R.sup.D37 L.sub.C394 R.sup.D17 R.sup.D58 L.sub.C586
R.sup.D143 R.sup.D149 L.sub.C11 R.sup.D11 R.sup.D11 L.sub.C203 R.sup.D1 R.sup.D40
L.sub.C395 R.sup.D17 R.sup.D59 L.sub.C587 R.sup.D143 R.sup.D151 L.sub.C12 R.sup.D12
R.sup.D12 L.sub.C204 R.sup.D1 R.sup.D41 L.sub.C396 R.sup.D17 R.sup.D78 L.sub.C588
R.sup.D143 R.sup.D154 L.sub.C13 R.sup.D13 R.sup.D13 L.sub.C205 R.sup.D1 R.sup.D42
L.sub.C397 R.sup.D17 R.sup.D79 L.sub.C589 R.sup.D143 R.sup.D155 L.sub.C14 R.sup.D14
R.sup.D14 L.sub.C206 R.sup.D1 R.sup.D43 L.sub.C398 R.sup.D17 R.sup.D81 L.sub.C590
R.sup.D143 R.sup.D161 L.sub.C15 R.sup.D15 R.sup.D15 L.sub.C207 R.sup.D1 R.sup.D48

L.sub.C399 R.sup.D17 R.sup.D87 L.sub.C591 R.sup.D143 R.sup.D175 L.sub.C16 R.sup.D16
R.sup.D16 L.sub.C208 R.sup.D1 R.sup.D49 L.sub.C400 R.sup.D17 R.sup.D88 L.sub.C592
R.sup.D144 R.sup.D3 L.sub.C17 R.sup.D17 R.sup.D17 L.sub.C209 R.sup.D1 R.sup.D50
L.sub.C401 R.sup.D17 R.sup.D89 L.sub.C593 R.sup.D144 R.sup.D5 L.sub.C18 R.sup.D18
R.sup.D18 L.sub.C210 R.sup.D1 R.sup.D54 L.sub.C402 R.sup.D17 R.sup.D93 L.sub.C594
R.sup.D144 R.sup.D17 L.sub.C19 R.sup.D19 R.sup.D19 L.sub.C211 R.sup.D1 R.sup.D55
L.sub.C403 R.sup.D17 R.sup.D116 L.sub.C595 R.sup.D144 R.sup.D18 L.sub.C20 R.sup.D20
R.sup.D20 L.sub.C212 R.sup.D1 R.sup.D58 L.sub.C404 R.sup.D17 R.sup.D117 L.sub.C596
R.sup.D144 R.sup.D20 L.sub.C21 R.sup.D21 R.sup.D21 L.sub.C213 R.sup.D1 R.sup.D59
L.sub.C405 R.sup.D17 R.sup.D118 L.sub.C597 R.sup.D144 R.sup.D22 L.sub.C22 R.sup.D22
R.sup.D22 L.sub.C214 R.sup.D1 R.sup.D78 L.sub.C406 R.sup.D17 R.sup.D119 L.sub.C598
R.sup.D144 R.sup.D37 L.sub.C23 R.sup.D23 R.sup.D23 L.sub.C215 R.sup.D1 R.sup.D79
L.sub.C407 R.sup.D17 R.sup.D120 L.sub.C599 R.sup.D144 R.sup.D40 L.sub.C24 R.sup.D24
R.sup.D24 L.sub.C216 R.sup.D1 R.sup.D81 L.sub.C408 R.sup.D17 R.sup.D133 L.sub.C600
R.sup.D144 R.sup.D41 L.sub.C25 R.sup.D25 R.sup.D25 L.sub.C217 R.sup.D1 R.sup.D87
L.sub.C409 R.sup.D17 R.sup.D134 L.sub.C601 R.sup.D144 R.sup.D42 L.sub.C26 R.sup.D26
R.sup.D26 L.sub.C218 R.sup.D1 R.sup.D88 L.sub.C410 R.sup.D17 R.sup.D135 L.sub.C602
R.sup.D144 R.sup.D43 L.sub.C27 R.sup.D27 R.sup.D27 L.sub.C219 R.sup.D1 R.sup.D89
L.sub.C411 R.sup.D17 R.sup.D136 L.sub.C603 R.sup.D144 R.sup.D48 L.sub.C28 R.sup.D28
R.sup.D28 L.sub.C220 R.sup.D1 R.sup.D93 L.sub.C412 R.sup.D17 R.sup.D143 L.sub.C604
R.sup.D144 R.sup.D49 L.sub.C29 R.sup.D29 R.sup.D29 L.sub.C221 R.sup.D1 R.sup.D116
L.sub.C413 R.sup.D17 R.sup.D144 L.sub.C605 R.sup.D144 R.sup.D54 L.sub.C30 R.sup.D30
R.sup.D30 L.sub.C222 R.sup.D1 R.sup.D117 L.sub.C414 R.sup.D17 R.sup.D145 L.sub.C606
R.sup.D144 R.sup.D58 L.sub.C31 R.sup.D31 R.sup.D31 L.sub.C223 R.sup.D1 R.sup.D118
L.sub.C415 R.sup.D17 R.sup.D146 L.sub.C607 R.sup.D144 R.sup.D59 L.sub.C32 R.sup.D32
R.sup.D32 L.sub.C224 R.sup.D1 R.sup.D119 L.sub.C416 R.sup.D17 R.sup.D147 L.sub.C608
R.sup.D144 R.sup.D78 L.sub.C33 R.sup.D33 R.sup.D33 L.sub.C225 R.sup.D1 R.sup.D120
L.sub.C417 R.sup.D17 R.sup.D149 L.sub.C609 R.sup.D144 R.sup.D79 L.sub.C34 R.sup.D34
R.sup.D34 L.sub.C226 R.sup.D1 R.sup.D133 L.sub.C418 R.sup.D17 R.sup.D151 L.sub.C610
R.sup.D144 R.sup.D81 L.sub.C35 R.sup.D35 R.sup.D35 L.sub.C227 R.sup.D1 R.sup.D134
L.sub.C419 R.sup.D17 R.sup.D154 L.sub.C611 R.sup.D144 R.sup.D87 L.sub.C36 R.sup.D36
R.sup.D36 L.sub.C228 R.sup.D1 R.sup.D135 L.sub.C420 R.sup.D17 R.sup.D155 L.sub.C613
R.sup.D144 R.sup.D88 L.sub.C37 R.sup.D37 R.sup.D37 L.sub.C229 R.sup.D1 R.sup.D136
L.sub.C421 R.sup.D17 R.sup.D161 L.sub.C613 R.sup.D144 R.sup.D89 L.sub.C38 R.sup.D38
R.sup.D38 L.sub.C230 R.sup.D1 R.sup.D143 L.sub.C422 R.sup.D17 R.sup.D175 L.sub.C614
R.sup.D144 R.sup.D93 L.sub.C39 R.sup.D39 R.sup.D39 L.sub.C231 R.sup.D1 R.sup.D144
L.sub.C423 R.sup.D50 R.sup.D3 L.sub.C615 R.sup.D144 R.sup.D116 L.sub.C40 R.sup.D40
R.sup.D40 L.sub.C232 R.sup.D1 R.sup.D145 L.sub.C424 R.sup.D50 R.sup.D5 L.sub.C616
R.sup.D144 R.sup.D117 L.sub.C41 R.sup.D41 R.sup.D41 L.sub.C233 R.sup.D1 R.sup.D146
L.sub.C425 R.sup.D50 R.sup.D18 L.sub.C617 R.sup.D144 R.sup.D118 L.sub.C42 R.sup.D42
R.sup.D42 L.sub.C234 R.sup.D1 R.sup.D147 L.sub.C426 R.sup.D50 R.sup.D20 L.sub.C618
R.sup.D144 R.sup.D119 L.sub.C43 R.sup.D43 R.sup.D43 L.sub.C235 R.sup.D1 R.sup.D149
L.sub.C427 R.sup.D50 R.sup.D22 L.sub.C619 R.sup.D144 R.sup.D120 L.sub.C44 R.sup.D44
R.sup.D44 L.sub.C236 R.sup.D1 R.sup.D151 L.sub.C428 R.sup.D50 R.sup.D37 L.sub.C620
R.sup.D144 R.sup.D133 L.sub.C45 R.sup.D45 R.sup.D45 L.sub.C237 R.sup.D1 R.sup.D154
L.sub.C429 R.sup.D50 R.sup.D40 L.sub.C621 R.sup.D144 R.sup.D134 L.sub.C46 R.sup.D46
R.sup.D46 L.sub.C238 R.sup.D1 R.sup.D155 L.sub.C430 R.sup.D50 R.sup.D41 L.sub.C622
R.sup.D144 R.sup.D135 L.sub.C47 R.sup.D47 R.sup.D47 L.sub.C239 R.sup.D1 R.sup.D161
L.sub.C431 R.sup.D50 R.sup.D42 L.sub.C623 R.sup.D144 R.sup.D136 L.sub.C48 R.sup.D48
R.sup.D48 L.sub.C240 R.sup.D1 R.sup.D175 L.sub.C432 R.sup.D50 R.sup.D43 L.sub.C624

R.sup.D144 R.sup.D155 L.sub.C49 R.sup.D49 R.sup.D49 L.sub.C241 R.sup.D4 R.sup.D3
L.sub.C433 R.sup.D50 R.sup.D48 L.sub.C625 R.sup.D144 R.sup.D146 L.sub.C50 R.sup.D50
R.sup.D50 L.sub.C242 R.sup.D4 R.sup.D5 L.sub.C434 R.sup.D50 R.sup.D49 L.sub.C626
R.sup.D144 R.sup.D147 L.sub.C51 R.sup.D51 R.sup.D51 L.sub.C243 R.sup.D4 R.sup.D9
L.sub.C435 R.sup.D50 R.sup.D54 L.sub.C627 R.sup.D144 R.sup.D149 L.sub.C52 R.sup.D52
R.sup.D52 L.sub.C244 R.sup.D4 R.sup.D10 L.sub.C436 R.sup.D50 R.sup.D55 L.sub.C628
R.sup.D144 R.sup.D151 L.sub.C53 R.sup.D53 R.sup.D53 L.sub.C245 R.sup.D4 R.sup.D17
L.sub.C437 R.sup.D50 R.sup.D58 L.sub.C629 R.sup.D144 R.sup.D154 L.sub.C54 R.sup.D54
R.sup.D54 L.sub.C246 R.sup.D4 R.sup.D18 L.sub.C438 R.sup.D50 R.sup.D59 L.sub.C630
R.sup.D144 R.sup.D155 L.sub.C55 R.sup.D55 R.sup.D55 L.sub.C247 R.sup.D4 R.sup.D20
L.sub.C439 R.sup.D50 R.sup.D78 L.sub.C631 R.sup.D144 R.sup.D161 L.sub.C56 R.sup.D56
R.sup.D56 L.sub.C248 R.sup.D4 R.sup.D22 L.sub.C440 R.sup.D50 R.sup.D79 L.sub.C632
R.sup.D144 R.sup.D175 L.sub.C57 R.sup.D57 R.sup.D57 L.sub.C249 R.sup.D4 R.sup.D37
L.sub.C441 R.sup.D50 R.sup.D81 L.sub.C633 R.sup.D145 R.sup.D3 L.sub.C58 R.sup.D58
R.sup.D58 L.sub.C250 R.sup.D4 R.sup.D40 L.sub.C442 R.sup.D50 R.sup.D87 L.sub.C634
R.sup.D145 R.sup.D5 L.sub.C59 R.sup.D59 R.sup.D59 L.sub.C251 R.sup.D4 R.sup.D41
L.sub.C443 R.sup.D50 R.sup.D88 L.sub.C635 R.sup.D145 R.sup.D17 L.sub.C60 R.sup.D60
R.sup.D60 L.sub.C252 R.sup.D4 R.sup.D42 L.sub.C444 R.sup.D50 R.sup.D89 L.sub.C636
R.sup.D145 R.sup.D18 L.sub.C61 R.sup.D61 R.sup.D61 L.sub.C253 R.sup.D4 R.sup.D43
L.sub.C445 R.sup.D50 R.sup.D93 L.sub.C637 R.sup.D145 R.sup.D20 L.sub.C62 R.sup.D62
R.sup.D62 L.sub.C254 R.sup.D4 R.sup.D48 L.sub.C446 R.sup.D50 R.sup.D116 L.sub.C638
R.sup.D145 R.sup.D22 L.sub.C63 R.sup.D63 R.sup.D63 L.sub.C255 R.sup.D4 R.sup.D49
L.sub.C447 R.sup.D50 R.sup.D117 L.sub.C639 R.sup.D145 R.sup.D37 L.sub.C64 R.sup.D64
R.sup.D64 L.sub.C256 R.sup.D4 R.sup.D50 L.sub.C448 R.sup.D50 R.sup.D118 L.sub.C640
R.sup.D145 R.sup.D40 L.sub.C65 R.sup.D65 R.sup.D65 L.sub.C257 R.sup.D4 R.sup.D54
L.sub.C449 R.sup.D50 R.sup.D119 L.sub.C641 R.sup.D145 R.sup.D41 L.sub.C66 R.sup.D66
R.sup.D66 L.sub.C258 R.sup.D4 R.sup.D55 L.sub.C450 R.sup.D50 R.sup.D120 L.sub.C642
R.sup.D145 R.sup.D42 L.sub.C67 R.sup.D67 R.sup.D67 L.sub.C259 R.sup.D4 R.sup.D58
L.sub.C451 R.sup.D50 R.sup.D133 L.sub.C643 R.sup.D145 R.sup.D43 L.sub.C68 R.sup.D68
R.sup.D68 L.sub.C260 R.sup.D4 R.sup.D59 L.sub.C452 R.sup.D50 R.sup.D134 L.sub.C644
R.sup.D145 R.sup.D48 L.sub.C69 R.sup.D69 R.sup.D69 L.sub.C261 R.sup.D4 R.sup.D78
L.sub.C453 R.sup.D50 R.sup.D135 L.sub.C645 R.sup.D145 R.sup.D49 L.sub.C70 R.sup.D70
R.sup.D70 L.sub.C262 R.sup.D4 R.sup.D79 L.sub.C454 R.sup.D50 R.sup.D136 L.sub.C646
R.sup.D145 R.sup.D54 L.sub.C71 R.sup.D71 R.sup.D71 L.sub.C263 R.sup.D4 R.sup.D81
L.sub.C455 R.sup.D50 R.sup.D143 L.sub.C647 R.sup.D145 R.sup.D58 L.sub.C72 R.sup.D72
R.sup.D72 L.sub.C264 R.sup.D4 R.sup.D87 L.sub.C456 R.sup.D50 R.sup.D144 L.sub.C648
R.sup.D145 R.sup.D59 L.sub.C73 R.sup.D73 R.sup.D73 L.sub.C265 R.sup.D4 R.sup.D88
L.sub.C457 R.sup.D50 R.sup.D145 L.sub.C649 R.sup.D145 R.sup.D78 L.sub.C74 R.sup.D74
R.sup.D74 L.sub.C266 R.sup.D4 R.sup.D89 L.sub.C458 R.sup.D50 R.sup.D146 L.sub.C650
R.sup.D145 R.sup.D79 L.sub.C75 R.sup.D75 R.sup.D75 L.sub.C267 R.sup.D4 R.sup.D93
L.sub.C459 R.sup.D50 R.sup.D147 L.sub.C651 R.sup.D145 R.sup.D81 L.sub.C76 R.sup.D76
R.sup.D76 L.sub.C268 R.sup.D4 R.sup.D116 L.sub.C460 R.sup.D50 R.sup.D149 L.sub.C652
R.sup.D145 R.sup.D87 L.sub.C77 R.sup.D77 R.sup.D77 L.sub.C269 R.sup.D4 R.sup.D117
L.sub.C461 R.sup.D50 R.sup.D151 L.sub.C653 R.sup.D145 R.sup.D88 L.sub.C78 R.sup.D78
R.sup.D78 L.sub.C270 R.sup.D4 R.sup.D118 L.sub.C462 R.sup.D50 R.sup.D154 L.sub.C654
R.sup.D145 R.sup.D89 L.sub.C79 R.sup.D79 R.sup.D79 L.sub.C271 R.sup.D4 R.sup.D119
L.sub.C463 R.sup.D50 R.sup.D155 L.sub.C655 R.sup.D145 R.sup.D93 L.sub.C80 R.sup.D80
R.sup.D80 L.sub.C272 R.sup.D4 R.sup.D120 L.sub.C464 R.sup.D50 R.sup.D161 L.sub.C656
R.sup.D145 R.sup.D116 L.sub.C81 R.sup.D81 R.sup.D81 L.sub.C273 R.sup.D4 R.sup.D133
L.sub.C465 R.sup.D50 R.sup.D175 L.sub.C657 R.sup.D145 R.sup.D117 L.sub.C82 R.sup.D82

R.sup.D82 L.sub.C274 R.sup.D4 R.sup.D134 L.sub.C466 R.sup.D55 R.sup.D3 L.sub.C558
R.sup.D145 R.sup.D118 L.sub.C83 R.sup.D83 R.sup.D83 L.sub.C275 R.sup.D4 R.sup.D135
L.sub.C467 R.sup.D55 R.sup.D5 L.sub.C659 R.sup.D145 R.sup.D119 L.sub.C84 R.sup.D84
R.sup.D84 L.sub.C276 R.sup.D4 R.sup.D136 L.sub.C468 R.sup.D55 R.sup.D18 L.sub.C660
R.sup.D145 R.sup.D120 L.sub.C85 R.sup.D85 R.sup.D85 L.sub.C277 R.sup.D4 R.sup.D143
L.sub.C469 R.sup.D55 R.sup.D20 L.sub.C661 R.sup.D145 R.sup.D133 L.sub.C86 R.sup.D86
R.sup.D86 L.sub.C278 R.sup.D4 R.sup.D144 L.sub.C470 R.sup.D55 R.sup.D22 L.sub.C662
R.sup.D145 R.sup.D134 L.sub.C87 R.sup.D87 R.sup.D87 L.sub.C279 R.sup.D4 R.sup.D145
L.sub.C471 R.sup.D55 R.sup.D37 L.sub.C663 R.sup.D145 R.sup.D135 L.sub.C88 R.sup.D88
R.sup.D88 L.sub.C280 R.sup.D4 R.sup.D146 L.sub.C472 R.sup.D55 R.sup.D40 L.sub.C664
R.sup.D145 R.sup.D136 L.sub.C89 R.sup.D89 R.sup.D89 L.sub.C281 R.sup.D4 R.sup.D147
L.sub.C473 R.sup.D55 R.sup.D41 L.sub.C665 R.sup.D145 R.sup.D146 L.sub.C90 R.sup.D90
R.sup.D90 L.sub.C282 R.sup.D4 R.sup.D149 L.sub.C474 R.sup.D55 R.sup.D42 L.sub.C666
R.sup.D145 R.sup.D147 L.sub.C91 R.sup.D91 R.sup.D91 L.sub.C283 R.sup.D4 R.sup.D151
L.sub.C475 R.sup.D55 R.sup.D43 L.sub.C667 R.sup.D145 R.sup.D149 L.sub.C92 R.sup.D92
R.sup.D92 L.sub.C284 R.sup.D4 R.sup.D154 L.sub.C476 R.sup.D55 R.sup.D48 L.sub.C668
R.sup.D145 R.sup.D151 L.sub.C93 R.sup.D93 R.sup.D93 L.sub.C285 R.sup.D4 R.sup.D155
L.sub.C477 R.sup.D55 R.sup.D49 L.sub.C669 R.sup.D145 R.sup.D154 L.sub.C94 R.sup.D94
R.sup.D94 L.sub.C286 R.sup.D4 R.sup.D161 L.sub.C478 R.sup.D55 R.sup.D54 L.sub.C670
R.sup.D145 R.sup.D155 L.sub.C95 R.sup.D95 R.sup.D95 L.sub.C287 R.sup.D4 R.sup.D175
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R.sup.D145 R.sup.D175 L.sub.C97 R.sup.D97 R.sup.D97 L.sub.C289 R.sup.D9 R.sup.D5
L.sub.C481 R.sup.D55 R.sup.D78 L.sub.C673 R.sup.D146 R.sup.D3 L.sub.C98 R.sup.D98
R.sup.D98 L.sub.C290 R.sup.D9 R.sup.D10 L.sub.C482 R.sup.D55 R.sup.D79 L.sub.C674
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R.sup.D100 L.sub.C292 R.sup.D9 R.sup.D18 L.sub.C484 R.sup.D55 R.sup.D87 L.sub.C676
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L.sub.C495 R.sup.D55 R.sup.D135 L.sub.C687 R.sup.D146 R.sup.D58 L.sub.C112 R.sup.D112
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L.sub.C499 R.sup.D55 R.sup.D145 L.sub.C691 R.sup.D146 R.sup.D81 L.sub.C116 R.sup.D116
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R.sup.D148 L.sub.C340 R.sup.D10 R.sup.D37 L.sub.C532 R.sup.D116 R.sup.D118 L.sub.C724

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L.sub.C537 R.sup.D116 R.sup.D135 L.sub.C729 R.sup.D133 R.sup.D79 L.sub.C154 R.sup.D154
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L.sub.C541 R.sup.D116 R.sup.D145 L.sub.C733 R.sup.D133 R.sup.D89 L.sub.C158 R.sup.D158
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R.sup.D168 L.sub.C360 R.sup.D10 R.sup.D117 L.sub.C552 R.sup.D143 R.sup.D17 L.sub.C744
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L.sub.C565 R.sup.D143 R.sup.D59 L.sub.C757 R.sup.D175 R.sup.D40 L.sub.C182 R.sup.D182

R.sup.D182 L.sub.C374 R.sup.D10 R.sup.D151 L.sub.C566 R.sup.D143 R.sup.D10 L.sub.C758
R.sup.D175 R.sup.D41 L.sub.C183 R.sup.D183 R.sup.D183 L.sub.C375 R.sup.D10 R.sup.D154
L.sub.C567 R.sup.D143 R.sup.D79 L.sub.C759 R.sup.D175 R.sup.D42 L.sub.C184 R.sup.D184
R.sup.D184 L.sub.C376 R.sup.D10 R.sup.D155 L.sub.C568 R.sup.D143 R.sup.D81 L.sub.C760
R.sup.D175 R.sup.D43 L.sub.C185 R.sup.D185 R.sup.D185 L.sub.C377 R.sup.D10 R.sup.D161
L.sub.C569 R.sup.D143 R.sup.D87 L.sub.C761 R.sup.D175 R.sup.D48 L.sub.C186 R.sup.D186
R.sup.D186 L.sub.C378 R.sup.D10 R.sup.D175 L.sub.C570 R.sup.D143 R.sup.D88 L.sub.C762
R.sup.D175 R.sup.D49 L.sub.C187 R.sup.D187 R.sup.D187 L.sub.C379 R.sup.D17 R.sup.D3
L.sub.C571 R.sup.D143 R.sup.D89 L.sub.C763 R.sup.D175 R.sup.D54 L.sub.C188 R.sup.D188
R.sup.D188 L.sub.C380 R.sup.D17 R.sup.D5 L.sub.C572 R.sup.D143 R.sup.D93 L.sub.C764
R.sup.D175 R.sup.D58 L.sub.C189 R.sup.D189 R.sup.D189 L.sub.C381 R.sup.D17 R.sup.D18
L.sub.C573 R.sup.D143 R.sup.D116 L.sub.C765 R.sup.D175 R.sup.D59 L.sub.C190 R.sup.D190
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R.sup.D192 L.sub.C384 R.sup.D17 R.sup.D37 L.sub.C576 R.sup.D143 R.sup.D119 L.sub.C768
R.sup.D175 R.sup.D81 L.sub.C769 R.sup.D193 R.sup.D193 L.sub.C877 R.sup.D1 R.sup.D193
L.sub.C985 R.sup.D4 R.sup.D193 L.sub.C1093 R.sup.D9 R.sup.D193 L.sub.C770 R.sup.D194
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L.sub.C826 R.sup.D17 R.sup.D196 L.sub.C934 R.sup.D50 R.sup.D196 L.sub.C1042 R.sup.D145
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R.sup.D231 L.sub.C1185 R.sup.D168 R.sup.D231 L.sub.C862 R.sup.D17 R.sup.D232 L.sub.C970
R.sup.D50 R.sup.D232 L.sub.C1078 R.sup.D145 R.sup.D232 L.sub.C1186 R.sup.D168
R.sup.D232 L.sub.C863 R.sup.D17 R.sup.D233 L.sub.C971 R.sup.D50 R.sup.D233 L.sub.C1079
R.sup.D145 R.sup.D233 L.sub.C1187 R.sup.D168 R.sup.D233 L.sub.C864 R.sup.D17 R.sup.D234
L.sub.C972 R.sup.D50 R.sup.D234 L.sub.C1080 R.sup.D145 R.sup.D234 L.sub.C1188
R.sup.D168 R.sup.D234 L.sub.C865 R.sup.D17 R.sup.D235 L.sub.C973 R.sup.D50 R.sup.D235
L.sub.C1081 R.sup.D145 R.sup.D235 L.sub.C1189 R.sup.D168 R.sup.D235 L.sub.C866
R.sup.D17 R.sup.D236 L.sub.C974 R.sup.D50 R.sup.D236 L.sub.C1082 R.sup.D145 R.sup.D236
L.sub.C1190 R.sup.D168 R.sup.D236 L.sub.C867 R.sup.D17 R.sup.D237 L.sub.C975 R.sup.D50
R.sup.D237 L.sub.C1083 R.sup.D145 R.sup.D237 L.sub.C1191 R.sup.D168 R.sup.D237
L.sub.C868 R.sup.D17 R.sup.D238 L.sub.C976 R.sup.D50 R.sup.D238 L.sub.C1084 R.sup.D145
R.sup.D238 L.sub.C1192 R.sup.D168 R.sup.D238 L.sub.C869 R.sup.D17 R.sup.D239 L.sub.C977
R.sup.D50 R.sup.D239 L.sub.C1085 R.sup.D145 R.sup.D239 L.sub.C1193 R.sup.D168
R.sup.D239 L.sub.C870 R.sup.D17 R.sup.D240 L.sub.C978 R.sup.D50 R.sup.D240 L.sub.C1086
R.sup.D145 R.sup.D240 L.sub.C1194 R.sup.D168 R.sup.D240 L.sub.C871 R.sup.D17 R.sup.D241
L.sub.C979 R.sup.D50 R.sup.D241 L.sub.C1087 R.sup.D145 R.sup.D241 L.sub.C1195
R.sup.D168 R.sup.D241 L.sub.C872 R.sup.D17 R.sup.D242 L.sub.C980 R.sup.D50 R.sup.D242
L.sub.C1088 R.sup.D145 R.sup.D242 L.sub.C1196 R.sup.D168 R.sup.D242 L.sub.C873
R.sup.D17 R.sup.D243 L.sub.C981 R.sup.D50 R.sup.D243 L.sub.C1089 R.sup.D145 R.sup.D243
L.sub.C1197 R.sup.D168 R.sup.D243 L.sub.C874 R.sup.D17 R.sup.D244 L.sub.C982 R.sup.D50
R.sup.D244 L.sub.C1090 R.sup.D145 R.sup.D244 L.sub.C1198 R.sup.D168 R.sup.D244
L.sub.C875 R.sup.D17 R.sup.D245 L.sub.C983 R.sup.D50 R.sup.D245 L.sub.C1091 R.sup.D145
R.sup.D245 L.sub.C1199 R.sup.D168 R.sup.D245 L.sub.C876 R.sup.D17 R.sup.D246 L.sub.C984
R.sup.D50 R.sup.D246 L.sub.C1092 R.sup.D145 R.sup.D246 L.sub.C1200 R.sup.D168
R.sup.D246 L.sub.C1201 R.sup.D10 R.sup.D193 L.sub.C1255 R.sup.D55 R.sup.D193
L.sub.C1309 R.sup.D37 R.sup.D193 L.sub.C1363 R.sup.D143 R.sup.D193 L.sub.C1202
R.sup.D10 R.sup.D194 L.sub.C1256 R.sup.D55 R.sup.D194 L.sub.C1310 R.sup.D37 R.sup.D194
L.sub.C1364 R.sup.D143 R.sup.D194 L.sub.C1203 R.sup.D10 R.sup.D195 L.sub.C1257
R.sup.D55 R.sup.D195 L.sub.C1311 R.sup.D37 R.sup.D195 L.sub.C1365 R.sup.D143 R.sup.D195
L.sub.C1204 R.sup.D10 R.sup.D196 L.sub.C1258 R.sup.D55 R.sup.D196 L.sub.C1312 R.sup.D37
R.sup.D196 L.sub.C1366 R.sup.D143 R.sup.D196 L.sub.C1205 R.sup.D10 R.sup.D197
L.sub.C1259 R.sup.D55 R.sup.D197 L.sub.C1313 R.sup.D37 R.sup.D197 L.sub.C1367
R.sup.D143 R.sup.D197 L.sub.C1206 R.sup.D10 R.sup.D198 L.sub.C1260 R.sup.D55 R.sup.D198
L.sub.C1314 R.sup.D37 R.sup.D198 L.sub.C1368 R.sup.D143 R.sup.D198 L.sub.C1207
R.sup.D10 R.sup.D199 L.sub.C1261 R.sup.D55 R.sup.D199 L.sub.C1315 R.sup.D37 R.sup.D199
L.sub.C1369 R.sup.D143 R.sup.D199 L.sub.C1208 R.sup.D10 R.sup.D200 L.sub.C1262
R.sup.D55 R.sup.D200 L.sub.C1316 R.sup.D37 R.sup.D200 L.sub.C1370 R.sup.D143 R.sup.D200
L.sub.C1209 R.sup.D10 R.sup.D201 L.sub.C1263 R.sup.D55 R.sup.D201 L.sub.C1317 R.sup.D37
R.sup.D201 L.sub.C1371 R.sup.D143 R.sup.D201 L.sub.C1210 R.sup.D10 R.sup.D202
L.sub.C1264 R.sup.D55 R.sup.D202 L.sub.C1318 R.sup.D37 R.sup.D202 L.sub.C1372
R.sup.D143 R.sup.D202 L.sub.C1211 R.sup.D10 R.sup.D203 L.sub.C1265 R.sup.D55 R.sup.D203
L.sub.C1319 R.sup.D37 R.sup.D203 L.sub.C1373 R.sup.D143 R.sup.D203 L.sub.C1212

R.sup.D10 R.sup.D20 L.sub.C1266 R.sup.D55 R.sup.D204 L.sub.C1320 R.sup.D37 R.sup.D204
L.sub.C1374 R.sup.D143 R.sup.D204 L.sub.C1213 R.sup.D10 R.sup.D205 L.sub.C1267
R.sup.D55 R.sup.D205 L.sub.C1321 R.sup.D37 R.sup.D205 L.sub.C1375 R.sup.D143 R.sup.D205
L.sub.C1214 R.sup.D10 R.sup.D206 L.sub.C1268 R.sup.D55 R.sup.D206 L.sub.C1322 R.sup.D37
R.sup.D206 L.sub.C1376 R.sup.D143 R.sup.D206 L.sub.C1215 R.sup.D10 R.sup.D207
L.sub.C1269 R.sup.D55 R.sup.D207 L.sub.C1323 R.sup.D37 R.sup.D207 L.sub.C1377
R.sup.D143 R.sup.D207 L.sub.C1216 R.sup.D10 R.sup.D208 L.sub.C1270 R.sup.D55 R.sup.D208
L.sub.C1324 R.sup.D37 R.sup.D208 L.sub.C1378 R.sup.D143 R.sup.D208 L.sub.C1217
R.sup.D10 R.sup.D209 L.sub.C1271 R.sup.D55 R.sup.D209 L.sub.C1325 R.sup.D37 R.sup.D209
L.sub.C1379 R.sup.D143 R.sup.D209 L.sub.C1218 R.sup.D10 R.sup.D210 L.sub.C1272
R.sup.D55 R.sup.D210 L.sub.C1326 R.sup.D37 R.sup.D210 L.sub.C1380 R.sup.D143 R.sup.D210
L.sub.C1219 R.sup.D10 R.sup.D211 L.sub.C1273 R.sup.D55 R.sup.D211 L.sub.C1327 R.sup.D37
R.sup.D211 L.sub.C1381 R.sup.D143 R.sup.D211 L.sub.C1220 R.sup.D10 R.sup.D212
L.sub.C1274 R.sup.D55 R.sup.D212 L.sub.C1328 R.sup.D37 R.sup.D212 L.sub.C1382
R.sup.D143 R.sup.D212 L.sub.C1221 R.sup.D10 R.sup.D213 L.sub.C1275 R.sup.D55 R.sup.D213
L.sub.C1329 R.sup.D37 R.sup.D213 L.sub.C1383 R.sup.D143 R.sup.D213 L.sub.C1222
R.sup.D10 R.sup.D214 L.sub.C1276 R.sup.D55 R.sup.D214 L.sub.C1330 R.sup.D37 R.sup.D214
L.sub.C1384 R.sup.D143 R.sup.D214 L.sub.C1223 R.sup.D10 R.sup.D215 L.sub.C1277
R.sup.D55 R.sup.D215 L.sub.C1331 R.sup.D37 R.sup.D215 L.sub.C1385 R.sup.D143 R.sup.D215
L.sub.C1224 R.sup.D10 R.sup.D216 L.sub.C1278 R.sup.D55 R.sup.D216 L.sub.C1332 R.sup.D37
R.sup.D216 L.sub.C1386 R.sup.D143 R.sup.D216 L.sub.C1225 R.sup.D10 R.sup.D217
L.sub.C1279 R.sup.D55 R.sup.D217 L.sub.C1333 R.sup.D37 R.sup.D217 L.sub.C1387
R.sup.D143 R.sup.D217 L.sub.C1226 R.sup.D10 R.sup.D218 L.sub.C1280 R.sup.D55 R.sup.D218
L.sub.C1334 R.sup.D37 R.sup.D218 L.sub.C1388 R.sup.D143 R.sup.D218 L.sub.C1227
R.sup.D10 R.sup.D219 L.sub.C1281 R.sup.D55 R.sup.D219 L.sub.C1335 R.sup.D37 R.sup.D219
L.sub.C1389 R.sup.D143 R.sup.D219 L.sub.C1228 R.sup.D10 R.sup.D220 L.sub.C1282
R.sup.D55 R.sup.D220 L.sub.C1336 R.sup.D37 R.sup.D220 L.sub.C1390 R.sup.D143 R.sup.D220
L.sub.C1229 R.sup.D10 R.sup.D221 L.sub.C1283 R.sup.D55 R.sup.D221 L.sub.C1337 R.sup.D37
R.sup.D221 L.sub.C1391 R.sup.D143 R.sup.D221 L.sub.C1230 R.sup.D10 R.sup.D222
L.sub.C1284 R.sup.D55 R.sup.D222 L.sub.C1338 R.sup.D37 R.sup.D222 L.sub.C1392
R.sup.D143 R.sup.D222 L.sub.C1231 R.sup.D10 R.sup.D223 L.sub.C1285 R.sup.D55 R.sup.D223
L.sub.C1339 R.sup.D37 R.sup.D223 L.sub.C1393 R.sup.D143 R.sup.D223 L.sub.C1232
R.sup.D10 R.sup.D224 L.sub.C1286 R.sup.D55 R.sup.D224 L.sub.C1340 R.sup.D37 R.sup.D224
L.sub.C1394 R.sup.D143 R.sup.D224 L.sub.C1233 R.sup.D10 R.sup.D225 L.sub.C1287
R.sup.D55 R.sup.D225 L.sub.C1341 R.sup.D37 R.sup.D225 L.sub.C1395 R.sup.D143 R.sup.D225
L.sub.C1234 R.sup.D10 R.sup.D226 L.sub.C1288 R.sup.D55 R.sup.D226 L.sub.C1342 R.sup.D37
R.sup.D226 L.sub.C1396 R.sup.D143 R.sup.D226 L.sub.C1235 R.sup.D10 R.sup.D227
L.sub.C1289 R.sup.D55 R.sup.D227 L.sub.C1343 R.sup.D37 R.sup.D227 L.sub.C1397
R.sup.D143 R.sup.D227 L.sub.C1236 R.sup.D10 R.sup.D228 L.sub.C1290 R.sup.D55 R.sup.D228
L.sub.C1344 R.sup.D37 R.sup.D228 L.sub.C1398 R.sup.D143 R.sup.D228 L.sub.C1237
R.sup.D10 R.sup.D229 L.sub.C1291 R.sup.D55 R.sup.D229 L.sub.C1345 R.sup.D37 R.sup.D229
L.sub.C1399 R.sup.D143 R.sup.D229 L.sub.C1238 R.sup.D10 R.sup.D230 L.sub.C1292
R.sup.D55 R.sup.D230 L.sub.C1346 R.sup.D37 R.sup.D230 L.sub.C1400 R.sup.D143 R.sup.D230
L.sub.C1239 R.sup.D10 R.sup.D231 L.sub.C1293 R.sup.D55 R.sup.D231 L.sub.C1347 R.sup.D37
R.sup.D231 L.sub.C1401 R.sup.D143 R.sup.D231 L.sub.C1240 R.sup.D10 R.sup.D232
L.sub.C1294 R.sup.D55 R.sup.D232 L.sub.C1348 R.sup.D37 R.sup.D232 L.sub.C1402
R.sup.D143 R.sup.D232 L.sub.C1241 R.sup.D10 R.sup.D233 L.sub.C1295 R.sup.D55 R.sup.D233
L.sub.C1349 R.sup.D37 R.sup.D233 L.sub.C1403 R.sup.D143 R.sup.D233 L.sub.C1242
R.sup.D10 R.sup.D234 L.sub.C1296 R.sup.D55 R.sup.D234 L.sub.C1350 R.sup.D37 R.sup.D234
L.sub.C1404 R.sup.D143 R.sup.D234 L.sub.C1243 R.sup.D10 R.sup.D235 L.sub.C1297

R.sup.D55 R.sup.D235 L.sub.C1351 R.sup.D37 R.sup.D235 L.sub.C1405 R.sup.D143 R.sup.D235
L.sub.C1244 R.sup.D10 R.sup.D236 L.sub.C1298 R.sup.D55 R.sup.D236 L.sub.C1352 R.sup.D37
R.sup.D236 L.sub.C1406 R.sup.D143 R.sup.D236 L.sub.C1245 R.sup.D10 R.sup.D237
L.sub.C1299 R.sup.D55 R.sup.D237 L.sub.C1353 R.sup.D37 R.sup.D237 L.sub.C1407
R.sup.D143 R.sup.D237 L.sub.C1246 R.sup.D10 R.sup.D238 L.sub.C1300 R.sup.D55 R.sup.D238
L.sub.C1354 R.sup.D37 R.sup.D238 L.sub.C1408 R.sup.D143 R.sup.D238 L.sub.C1247
R.sup.D10 R.sup.D239 L.sub.C1301 R.sup.D55 R.sup.D239 L.sub.C1355 R.sup.D37 R.sup.D239
L.sub.C1409 R.sup.D143 R.sup.D239 L.sub.C1248 R.sup.D10 R.sup.D240 L.sub.C1302
R.sup.D55 R.sup.D240 L.sub.C1356 R.sup.D37 R.sup.D240 L.sub.C1410 R.sup.D143 R.sup.D240
L.sub.C1249 R.sup.D10 R.sup.D241 L.sub.C1303 R.sup.D55 R.sup.D241 L.sub.C1357 R.sup.D37
R.sup.D241 L.sub.C1411 R.sup.D143 R.sup.D241 L.sub.C1250 R.sup.D10 R.sup.D242
L.sub.C1304 R.sup.D55 R.sup.D242 L.sub.C1358 R.sup.D37 R.sup.D242 L.sub.C1412
R.sup.D143 R.sup.D242 L.sub.C1251 R.sup.D10 R.sup.D243 L.sub.C1305 R.sup.D55 R.sup.D243
L.sub.C1359 R.sup.D37 R.sup.D243 L.sub.C1413 R.sup.D143 R.sup.D243 L.sub.C1252
R.sup.D10 R.sup.D244 L.sub.C1306 R.sup.D55 R.sup.D244 L.sub.C1360 R.sup.D37 R.sup.D244
L.sub.C1414 R.sup.D143 R.sup.D244 L.sub.C1253 R.sup.D10 R.sup.D245 L.sub.C1307
R.sup.D55 R.sup.D245 L.sub.C1361 R.sup.D37 R.sup.D245 L.sub.C1415 R.sup.D143 R.sup.D245
L.sub.C1254 R.sup.D10 R.sup.D246 L.sub.C1308 R.sup.D55 R.sup.D246 L.sub.C1362 R.sup.D37
R.sup.D246 L.sub.C1416 R.sup.D143 R.sup.D246

[0205] wherein R.sup.D1 to R.sup.D246 have the structures defined in the following LIST 10:

##STR00390## ##STR00391## ##STR00392## ##STR00393## ##STR00394## ##STR00395##
##STR00396## ##STR00397## ##STR00398## ##STR00399## ##STR00400## ##STR00401##
##STR00402## ##STR00403## ##STR00404## ##STR00405## ##STR00406## ##STR00407##
##STR00408## ##STR00409## ##STR00410## ##STR00411## ##STR00412## ##STR00413##
##STR00414##

[0206] In some embodiments, L.sub.A is selected from the group consisting of the structures of LIST 1, LIST 2, LIST 3a, and LIST 3, and L.sub.B is selected from the group consisting of the structures of LIST 6, LIST 7, and LIST 8. In some embodiments, L.sub.A is selected from the group consisting of the structures of LIST 1 and L.sub.B is selected from the group consisting of the structures of LIST 8. In some embodiments, L.sub.A is selected from the group consisting of the structures of LIST 2 and L.sub.B is selected from the group consisting of the structures of LIST 8. In some embodiments, L.sub.A is selected from L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-12-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) and from L.sub.A-19-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-24-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) and from Ir(L.sub.A-13-(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.1)(R.sup.1)(R.sup.H1)).sub.2L.sub.B1 to Ir(L.sub.A-18-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) and from L.sub.A-25-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) of LIST 3 as defined herein, and L.sub.B is selected from the group consisting of the structures of LIST 8 of L.sub.Bk wherein k is an integer from 1 to 474. In some embodiments, L.sub.A is selected from L.sub.A-41-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.Z1) to L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144) of LIST 3a as defined herein, and L.sub.B is selected from the group consisting of the structures of LIST 8 of L.sub.Bk wherein k is an integer from 1 to 474.

[0207] In some embodiments, the compound can be Ir(L.sub.A).sub.2(L.sub.B), Ir(L.sub.A)(L.sub.B).sub.2, or Ir(L.sub.A)(L.sub.B)(L.sub.C). In some of these embodiments, L.sub.A can have a Formula I as defined herein. In some of these embodiments, L.sub.B can have a Formula II as defined herein. In some of these embodiments, L.sub.A can be selected from the group consisting of the structures of LIST 1, LIST 2, LIST 3, and LIST 3a as defined herein. In some of these embodiments, L.sub.B can be selected from the group consisting of the structures of LIST 6,

LIST 7, and LIST 8 as defined herein. In some of these embodiments, the compound can be Ir(L.sub.A-i-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H)).sub.2(L.sub.B), Ir(L.sub.A-i'-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H)).sub.2(L.sub.B), Ir(L.sub.A-i-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H))(L.sub.B).sub.2, Ir(L.sub.A-i'-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H))(B).sub.2, Ir(L.sub.A).sub.2(L.sub.Bk), Ir(L.sub.A)(L.sub.Bk).sub.2, Ir(L.sub.A-i-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H)).sub.2(L.sub.Bk) consisting of the compounds of Ir(L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1)).sub.2(L.sub.B1) to Ir(L.sub.A-12-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49)).sub.2(L.sub.B474) and Ir(L.sub.A-19-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1)).sub.2(L.sub.B1) to Ir(L.sub.A-24-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49)).sub.2(L.sub.B474), Ir(L.sub.A-i'(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H)).sub.2(L.sub.Bk) consisting of the compounds of Ir(L.sub.A-13-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1)).sub.2(L.sub.B1) to Ir(L.sub.A-18-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49)).sub.2(L.sub.B474); and Ir(L.sub.A-25-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1)).sub.2(L.sub.B1) to Ir(L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49)).sub.2(L.sub.B474), Ir(L.sub.A-i-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H))(L.sub.Bk).sub.2 consisting of the compounds of Ir(L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.B1).sub.2 to Ir(L.sub.A-12-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49)L.sub.B474).sub.2; and Ir(L.sub.A-19-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))B.sub.1).sub.2 to Ir(L.sub.A-24-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(B.sub.474).sub.2, Ir(L.sub.A-i'(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H))(L.sub.Bk).sub.2 consisting of the compounds of Ir(L.sub.A-13-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.H1))(L.sub.B1).sub.2 to Ir(L.sub.A-18-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474).sub.2; and Ir(L.sub.A-25-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.B1).sub.2 to Ir(L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474).sub.2, Ir(L.sub.A-i-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H))(L.sub.Bk)(L.sub.Cj-I) consisting of the compounds of Ir(L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.B1)(L.sub.C1-I) to Ir(L.sub.A-12-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-I); and Ir(L.sub.A-19-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.H1)) L.sub.B1)(L.sub.C1-I) to Ir(L.sub.A-24-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-I), Ir(L.sub.A-i'-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H))(L.sub.Bk)(L.sub.Cj-I) consisting of the compounds of Ir(L.sub.A-13-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.B1)(L.sub.C1-I) to Ir(L.sub.A-18-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-I), and Ir(L.sub.A-25-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.H1)) (L.sub.B1)-(L.sub.C1-I) to Ir(L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-I), Ir(L.sub.A-1-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.H))(L.sub.Bk)(L.sub.Cj-II) consisting of the compounds of Ir(L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.B1)(L.sub.C1-II) to Ir(L.sub.A-12-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-II), and Ir(L.sub.A-19-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.H1))-(L.sub.B1)(L.sub.C1-II) to Ir(L.sub.A-24-(R .sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-II), or Ir(L.sub.A-i'-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.H))(L.sub.Bk)(L.sub.Cj-II) consisting of the compounds of Ir(L.sub.A-13-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1))(L.sub.1)(L.sub.CI-II) to Ir(L.sub.A-18-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(B.sub.474(L.sub.C1416-II); and Ir(L.sub.A-25-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sub.H1))(L.sub.B1)(L.sub.C1-II) to Ir(L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49))(L.sub.B474)(L.sub.C1416-II)

(R.sup.H49))-(L.sub.B474)(L.sub.C1416-II).

[0208] In some of these embodiments, the compound can be Ir(L.sub.A-w-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.Z)).sub.2(L.sub.B), Ir(L.sub.A-w-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z))(L.sub.B).sub.2, Ir(L.sub.A-w(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z)).sub.2(L.sub.Bk) consisting of the compounds of Ir(L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1(R.sub.Z1)).sub.2(L.sub.B1) to Ir(L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144)).sub.2(L.sub.B474), Ir(L.sub.A-w-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sup.Z))(L.sub.Bk).sub.2 consisting of the compounds of Ir(L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1))(L.sub.B1).sub.2 to Ir(L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144))(L.sub.B474).sub.2, Ir(L.sub.A-w(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z))(L.sub.Bk)(L.sub.Cj-I) consisting of the compounds of Ir(L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1))(L.sub.B1)(L.sub.C1-I) to Ir(L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144))(L.sub.B474)(L.sub.C416-I), Ir(L.sub.A-w-(R.sup.EA)(R.sup.EB)(R.sup.EC)(R.sup.ED)(R.sup.EE)(R.sub.Z)) (L.sub.Bk)(L.sub.Cj-II) consisting of the compounds of Ir(L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1))(L.sub.B1)(L.sub.C1-II) to Ir(L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144)) (L.sub.B474)(L.sub.C1416-II).

[0209] In some embodiments, the compound is selected from the group consisting of only those compounds whose L.sub.Bk corresponds to one of the following: L.sub.B1, L.sub.B2, L.sub.B18, L.sub.B28, L.sub.B38, L.sub.B108, L.sub.B118, L.sub.B122, L.sub.B124, L.sub.B126, L.sub.B128, L.sub.B130, L.sub.B132, L.sub.B134, L.sub.B136, L.sub.B138, L.sub.B140, L.sub.B142, L.sub.B144, L.sub.B156, L.sub.B158, L.sub.B160, L.sub.B162, L.sub.B164, L.sub.B168, L.sub.B172, L.sub.B175, L.sub.B204, L.sub.B206, L.sub.B214, L.sub.B216, L.sub.B218, L.sub.B220, L.sub.B222, L.sub.B231, L.sub.B233, L.sub.B235, L.sub.B237, L.sub.B240, L.sub.B242, L.sub.B244, L.sub.B246, L.sub.B248, L.sub.B250, L.sub.B252, L.sub.B254, L.sub.B256, L.sub.B258, L.sub.B260, L.sub.B262, L.sub.B264, L.sub.B265, L.sub.B266, L.sub.B267, L.sub.B268, L.sub.B269, and L.sub.B270.

[0210] In some embodiments, the compound is selected from the group consisting of only those compounds whose L.sub.Bk corresponds to one of the following: L.sub.B1, L.sub.B2, L.sub.B18, L.sub.B28, L.sub.B38, L.sub.B108, L.sub.B118, L.sub.B122, L.sub.B126, L.sub.B128, L.sub.B132, L.sub.B136, L.sub.B138, L.sub.B142, L.sub.B156, L.sub.B162, L.sub.B204, L.sub.B206, L.sub.B214, L.sub.B216, L.sub.B218, L.sub.B220, L.sub.B231, L.sub.B233, L.sub.B237, L.sub.B264, L.sub.B265, L.sub.B266, L.sub.B267, L.sub.B268, L.sub.B269, and L.sub.B270.

[0211] In some embodiments, the compound is selected from the group consisting of only those compounds having L.sub.Cj-I or L.sub.Cj-II ligand whose corresponding R.sup.201 and R.sup.202 are defined to be one of the following structures: R.sup.D1, R.sup.D3, R.sup.D4, R.sup.D5, R.sup.D9, R.sup.D10, R.sup.D17, R.sup.D18, R.sup.D20, R.sup.D22, R.sup.D37, R.sup.D40, R.sup.D41, R.sup.D42, R.sup.D43, R.sup.D48, R.sup.D49, R.sup.D50, R.sup.D54, R.sup.D55, R.sup.D58, R.sup.D59, R.sup.D78, R.sup.D79, R.sup.D81, R.sup.D87, R.sup.D88, R.sup.D89, R.sup.D93, R.sup.D116, R.sup.D117, R.sup.D118, R.sup.D119, R.sup.D120, R.sup.D133, R.sup.D134, R.sup.D135, R.sup.D136, R.sup.D143, R.sup.D144, R.sup.D145, R.sup.D146, R.sup.D147, R.sup.D149, R.sup.D151, R.sup.D154, R.sup.D155, R.sup.D161, R.sup.D175, R.sup.D190, R.sup.D193, R.sup.D200, R.sup.D201, R.sup.D206, R.sup.D210, R.sup.D214, R.sup.D215, R.sup.D216, R.sup.D218, R.sup.D219, R.sup.D220, R.sup.D227, R.sup.D237, R.sup.D241, R.sup.D242, R.sup.D245, and R.sup.D246.

[0212] In some embodiments, the compound is selected from the group consisting of only those compounds having L.sub.Cj-I or L.sub.Cj-II ligand whose corresponding R.sup.201 and R.sup.202

are defined to be one of selected from the following structures: R.sup.D1, R.sup.D3, R.sup.D4, R.sup.D5, R.sup.D9, R.sup.D10, R.sup.D17, R.sup.D22, R.sup.D43, R.sup.D50, R.sup.D78, R.sup.D116, R.sup.D118, R.sup.D133, R.sup.D134, R.sup.D135, R.sup.D136, R.sup.D143, R.sup.D144, R.sup.D145, R.sup.D146, R.sup.D149, R.sup.D151, R.sup.D154, R.sup.D155, R.sup.D190, R.sup.D193, R.sup.D200, R.sup.D201, R.sup.D206, R.sup.D210, R.sup.D214, R.sup.D215, R.sup.D216, R.sup.D218, R.sup.D219, R.sup.D220, R.sup.D227, R.sup.D237, R.sup.D241, R.sup.D242, R.sup.D245, and R.sup.D246.

[0213] In some embodiments, the compound is selected from the group consisting of only those compounds having one of the following structures for the L.sub.Cj-I ligand:

##STR00415## ##STR00416## ##STR00417## ##STR00418## ##STR00419## ##STR00420##

In some embodiments, the compound is selected from the group consisting of the structures of the following LIST 11:

##STR00421## ##STR00422## ##STR00423## ##STR00424## ##STR00425## ##STR00426##

##STR00427## ##STR00428## ##STR00429## ##STR00430## ##STR00431## ##STR00432##

##STR00433## ##STR00434## ##STR00435## ##STR00436## ##STR00437##

##STR00438## ##STR00439## ##STR00440## ##STR00441## ##STR00442## ##STR00443##

##STR00444## ##STR00445## ##STR00446## ##STR00447## ##STR00448## ##STR00449##

##STR00450## ##STR00451## ##STR00452## ##STR00453## ##STR00454## ##STR00455##

##STR00456## ##STR00457## ##STR00458## ##STR00459## ##STR00460## ##STR00461##

##STR00462## ##STR00463##

##STR00464## ##STR00465## ##STR00466## ##STR00467## ##STR00468## ##STR00469##

##STR00470## ##STR00471## ##STR00472## ##STR00473## ##STR00474## ##STR00475##

##STR00476## ##STR00477## ##STR00478## ##STR00479## ##STR00480## ##STR00481##

##STR00482## ##STR00483##

[0214] In some embodiments, the compound has a Formula III,

##STR00484##

wherein: [0215] M.sup.1 is Pd or Pt; [0216] moieties E and F are each independently monocyclic or polycyclic ring structure comprising 5-membered and/or 6-membered carbocyclic or heterocyclic rings; [0217] Z.sup.1 and Z.sup.2 are each independently C or N; [0218] K, K.sup.1 and K.sup.2 are each independently selected from the group consisting of a direct bond, O, and S, wherein at least two of them are direct bonds; [0219] L.sup.1, L.sup.2, and L.sup.3 are each independently absent or selected from the group consisting of a direct bond, BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO.sub.2, CR, CRR', SiRR', GeRR', alkylene, cycloalkyl, aryl, cycloalkylene, arylene, heteroarylene, and combinations thereof, wherein at least one of L.sup.1 and L.sup.2 is present; [0220] R.sup.E and R.sup.F each independently represents zero, mono, or up to a maximum allowed number of substitutions; [0221] each of R, R', R.sup.E, and R.sup.F is independently a hydrogen or a substituent selected from the group consisting of the Preferred Substituents defined herein; and [0222] any two adjacent R, R', R.sup.A, R.sup.B, R.sup.C, R.sup.E, and R.sup.F can be joined or fused together to form a ring where chemically feasible.

[0223] It should be understood that L.sup.3 when present can be linked to R.sup.A or to a ring formed by two R.sup.A even though it's not explicitly shown in Formula III. It should be also understood that L.sup.1 when present can be also linked to R.sup.C.

[0224] In some embodiments of Formula III, moiety E and moiety F are both 6-membered aromatic rings. In some embodiments of Formula III, moiety F is a 5-membered or 6-membered heteroaromatic ring.

[0225] In some embodiments of Formula III, L.sup.1 is O or CRR'.

[0226] In some embodiments of Formula III, Z.sup.2 is N and Z.sup.1 is C. In some embodiments of Formula III, Z.sup.2 is C and Z.sup.1 is N.

[0227] In some embodiments of Formula III, L.sup.2 is a direct bond.

[0228] In some embodiments of Formula III, L.sup.2 is NR.

[0229] In some embodiments of Formula III, K, K.sup.1, and K.sup.2 are all direct bonds.

[0230] In some embodiments of Formula III, one of K, K.sup.1, K.sup.2 is 0.

[0231] In some embodiments of Formula III, at least one R.sup.A, R.sup.B, R.sup.C, R.sup.E, or R.sup.F is partially or fully deuterated. In some embodiments, at least one R.sup.A is partially or fully deuterated. In some embodiments, at least one R.sup.B is partially or fully deuterated. In some embodiments, at least one R.sup.C is partially or fully deuterated. In some embodiments, at least one R.sup.E is partially or fully deuterated. In some embodiments, at least one R.sup.F is partially or fully deuterated. In some embodiments of Formula III, at least R or R' if present is partially or fully deuterated.

[0232] In some embodiments of Formula III, at least one R.sup.A is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.AA is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0233] In some embodiments of Formula III, at least one R.sup.B is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.B is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0234] In some embodiments of Formula III, at least one R.sub.C is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.C is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.C is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.C is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.C is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0235] In some embodiments of Formula III, at least one R.sup.E is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sup.E is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sup.E is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sup.E is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sup.E is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0236] In some embodiments of Formula III, at least one R.sub.F is/comprises an electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, at least one of R.sub.F is/comprises an electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, at least one of R.sub.F is/comprises an electron-withdrawing group from LIST EWG 3 as defined herein. In some embodiments, at least one of R.sub.F is/comprises an electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, at least one of R.sub.F is/comprises an electron-withdrawing group from LIST Pi-EWG as defined herein.

[0237] In some embodiments of Formula III, Formula III comprises at least one electron-withdrawing group from LIST EWG 1 as defined herein. In some embodiments, Formula III comprises at least one electron-withdrawing group from LIST EWG 2 as defined herein. In some embodiments, Formula III comprises at least one electron-withdrawing group from LIST EWG 3 as

defined herein. In some embodiments, Formula III comprises at least one electron-withdrawing group from LIST EWG 4 as defined herein. In some embodiments, Formula III comprises at least one electron-withdrawing group from LIST Pi-EWG as defined herein.

[0238] In some embodiments, the compound having a first ligand L.sub.A of Formula I described herein can be at least 30% deuterated, at least 40% deuterated, at least 50% deuterated, at least 60% deuterated, at least 70% deuterated, at least 80% deuterated, at least 90% deuterated, at least 95% deuterated, at least 99% deuterated, or 100% deuterated. As used herein, percent deuteration has its ordinary meaning and includes the percent of possible hydrogen atoms (e.g., positions that are hydrogen or deuterium) that are replaced by deuterium atoms.

[0239] In some embodiments of heteroleptic compound having the formula of $M(L_{\text{sub.A}})_{\text{sub.p}}(L_{\text{sub.B}})_{\text{sub.q}}(L_{\text{sub.C}})_{\text{sub.r}}$ as defined above, the ligand L.sub.A has a first substituent R.sup.I, where the first substituent R.sup.I has a first atom a-I that is the farthest away from the metal M among all atoms in the ligand L.sub.A. Additionally, the ligand L.sub.B, if present, has a second substituent R.sup.II, where the second substituent R.sup.II has a first atom a-II that is the farthest away from the metal M among all atoms in the ligand L.sub.B. Furthermore, the ligand L.sub.C, if present, has a third substituent R.sup.III, where the third substituent R.sup.III has a first atom a-III that is the farthest away from the metal M among all atoms in the ligand L.sub.C.

[0240] In such heteroleptic compounds, vectors V.sub.D1, V.sub.D2, and V.sub.D3 can be defined that are defined as follows. V.sub.D1 represents the direction from the metal M to the first atom a-I and the vector V.sub.D1 has a value D.sup.1 that represents the straight line distance between the metal M and the first atom a-I in the first substituent R.sup.I. V.sub.D2 represents the direction from the metal M to the first atom a-II and the vector V.sub.D2 has a value D.sup.2 that represents the straight line distance between the metal M and the first atom a-II in the second substituent R.sup.II. V.sub.D3 represents the direction from the metal M to the first atom a-III and the vector V.sub.D3 has a value D.sup.3 that represents the straight line distance between the metal M and the first atom a-III in the third substituent R.sup.III.

[0241] In such heteroleptic compounds, a sphere having a radius r is defined whose center is the metal M and the radius r is the smallest radius that will allow the sphere to enclose all atoms in the compound that are not part of the substituents R.sup.I, R.sup.II and R.sup.III; and where at least one of D.sup.1, D.sup.2, and D.sup.3 is greater than the radius r by at least 1.5 Å. In some embodiments, at least one of D.sup.1, D.sup.2, and D.sup.3 is greater than the radius r by at least 2.9, 3.0, 4.3, 4.4, 5.2, 5.9, 7.3, 8.8, 10.3, 13.1, 17.6, or 19.1 Å.

[0242] In some embodiments of such heteroleptic compound, the compound has a transition dipole moment axis and angles are defined between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3, where at least one of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 is less than 40°. In some embodiments, at least one of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 is less than 30°. In some embodiments, at least one of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 is less than 20°. In some embodiments, at least one of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 is less than 15°. In some embodiments, at least one of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 is less than 10°. In some embodiments, at least two of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 20°. In some embodiments, at least two of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 15°. In some embodiments, at least two of the angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 10°.

[0243] In some embodiments, all three angles between the transition dipole moment axis and the

vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 20°. In some embodiments, all three angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 15°. In some embodiments, all three angles between the transition dipole moment axis and the vectors V.sub.D1, V.sub.D2, and V.sub.D3 are less than 10°.

[0244] In some embodiments of such heteroleptic compounds, the compound has a vertical dipole ratio (VDR) of 0.33 or less. In some embodiments of such heteroleptic compounds, the compound has a VDR of 0.30 or less. In some embodiments of such heteroleptic compounds, the compound has a VDR of 0.25 or less. In some embodiments of such heteroleptic compounds, the compound has a VDR of 0.20 or less. In some embodiments of such heteroleptic compounds, the compound has a VDR of 0.15 or less.

[0245] One of ordinary skill in the art would readily understand the meaning of the terms transition dipole moment axis of a compound and vertical dipole ratio of a compound.

Nevertheless, the meaning of these terms can be found in U.S. Pat. No. 10,672,997 whose disclosure is incorporated herein by reference in its entirety. In U.S. Pat. No. 10,672,997, horizontal dipole ratio (HDR) of a compound, rather than VDR, is discussed. However, one skilled in the art readily understands that $VDR=1-HDR$.

C. The OLEDs and the Devices of the Present Disclosure

[0246] In another aspect, the present disclosure also provides an OLED device comprising a first organic layer that contains a compound as disclosed in the above compounds section of the present disclosure.

[0247] In some embodiments, the OLED comprises: an anode; a cathode; and an organic layer disposed between the anode and the cathode, where the organic layer comprises a compound comprising a first ligand L.sub.A of Formula I as described herein.

[0248] In some embodiments, the organic layer may be an emissive layer and the compound as described herein may be an emissive dopant or a non-emissive dopant.

[0249] In some embodiments, the emissive layer comprises one or more quantum dots.

[0250] In some embodiments, the organic layer may further comprise a host, wherein the host comprises a triphenylene containing benzo-fused thiophene or benzo-fused furan, wherein any substituent in the host is an unfused substituent independently selected from the group consisting of C.sub.NH.sub.2n+1, OC.sub.nH.sub.2n+1, OAr.sub.1, N(C.sub.nH.sub.2n+1).sub.2, N(Ar.sub.1)(Ar.sub.2), CH=CH—C.sub.nH.sub.2n+1, C≡CC.sub.nH.sub.2n+1, Ar.sub.1, Ar.sub.1—Ar.sub.2, C.sub.nH.sub.2n—Ar.sub.1, or no substitution, wherein n is an integer from 1 to 10; and wherein Ar.sub.i and Ar.sub.2 are independently selected from the group consisting of benzene, biphenyl, naphthalene, triphenylene, carbazole, and heteroaromatic analogs thereof.

[0251] In some embodiments, the organic layer may further comprise a host, wherein host comprises at least one chemical group selected from the group consisting of triphenylene, carbazole, indolocarbazole, dibenzothiophene, dibenzofuran, dibenzoselenophene, 5λ2-benzo[d]benzo[4,5]imidazo[3,2-a]imidazole, 5,9-dioxa-13b-boranaphtho[3,2,1-de]anthracene, triazine, boryl, silyl, aza-triphenylene, aza-carbazole, aza-indolocarbazole, aza-dibenzothiophene, aza-dibenzofuran, aza-dibenzoselenophene, aza-5λ2-benzo[d]benzo[4,5]imidazo[3,2-a]imidazole, and aza-(5,9-dioxa-13b-boranaphtho[3,2,1-de]anthracene).

[0252] In some embodiments, the host can be selected from the group consisting of the structures of the following

##STR00485## ##STR00486## ##STR00487## ##STR00488## ##STR00489## ##STR00490##
##STR00491## ##STR00492## ##STR00493## ##STR00494## ##STR00495## ##STR00496##
##STR00497## ##STR00498## ##STR00499## ##STR00500## ##STR00501## ##STR00502##
##STR00503##

wherein:

[0253] each of X.sup.1 to X.sup.24 is independently C or N;

[0254] L' is a direct bond or an organic linker;

[0255] each Y.sup.A is independently selected from the group consisting of absent a bond, O, S, Se, CRR', SiRR', GeRR', NR, BR, BRR';

[0256] each of R.sup.A', R.sup.B', R.sup.C', R.sup.D', R.sup.E', R.sup.F', and R.sup.G' independently represents mono, up to the maximum substitutions, or no substitutions;

[0257] each R, R', R.sup.A', R.sup.B', R.sup.C', R.sup.D', R.sup.E', R.sup.F', and R.sup.G' is independently a hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, selenyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, boryl, and combinations thereof; and

[0258] two adjacent of R.sup.A', R.sup.B', R.sup.C', R.sup.D', R.sup.E', R.sup.F', and R.sup.G' are optionally joined or fused to form a ring.

[0259] In some embodiments, the host may be selected from the HOST Group 2 consisting of: ##STR00504## ##STR00505## ##STR00506## ##STR00507## ##STR00508## ##STR00509## and combinations thereof.

[0260] In some embodiments, the organic layer may further comprise a host, wherein the host comprises a metal complex.

[0261] In some embodiments, the emissive layer can comprise two hosts, a first host and a second host. In some embodiments, the first host is a hole transporting host, and the second host is an electron transporting host. In some embodiments, the first host and the second host can form an exciplex.

[0262] In some embodiments, the compound as described herein may be a sensitizer; wherein the device may further comprise an acceptor; and wherein the acceptor may be selected from the group consisting of fluorescent emitter, delayed fluorescence emitter, and combination thereof.

[0263] In yet another aspect, the OLED of the present disclosure may also comprise an emissive region containing a compound as disclosed in the above compounds section of the present disclosure.

[0264] In some embodiments, the emissive region can comprise a compound comprising a first ligand L.sub.A of Formula I as described herein.

[0265] In some embodiments, at least one of the anode, the cathode, or a new layer disposed over the organic emissive layer functions as an enhancement layer. The enhancement layer comprises a plasmonic material exhibiting surface plasmon resonance that non-radiatively couples to the emitter material and transfers excited state energy from the emitter material to non-radiative mode of surface plasmon polariton. The enhancement layer is provided no more than a threshold distance away from the organic emissive layer, wherein the emitter material has a total non-radiative decay rate constant and a total radiative decay rate constant due to the presence of the enhancement layer and the threshold distance is where the total non-radiative decay rate constant is equal to the total radiative decay rate constant. In some embodiments, the OLED further comprises an outcoupling layer. In some embodiments, the outcoupling layer is disposed over the enhancement layer on the opposite side of the organic emissive layer. In some embodiments, the outcoupling layer is disposed on opposite side of the emissive layer from the enhancement layer but still outcouples energy from the surface plasmon mode of the enhancement layer. The outcoupling layer scatters the energy from the surface plasmon polaritons. In some embodiments this energy is scattered as photons to free space. In other embodiments, the energy is scattered from the surface plasmon mode into other modes of the device such as but not limited to the organic waveguide mode, the substrate mode, or another waveguiding mode. If energy is scattered to the non-free space mode of the OLED other outcoupling schemes could be incorporated to extract that energy to free space. In some embodiments, one or more intervening layer can be disposed between the enhancement layer and the outcoupling layer. The examples for intervening layer(s) can be dielectric materials, including organic, inorganic, perovskites, oxides, and may include stacks and/or mixtures of these

materials.

[0266] The enhancement layer modifies the effective properties of the medium in which the emitter material resides resulting in any or all of the following: a decreased rate of emission, a modification of emission line-shape, a change in emission intensity with angle, a change in the stability of the emitter material, a change in the efficiency of the OLED, and reduced efficiency roll-off of the OLED device. Placement of the enhancement layer on the cathode side, anode side, or on both sides results in OLED devices which take advantage of any of the above-mentioned effects. In addition to the specific functional layers mentioned herein and illustrated in the various OLED examples shown in the figures, the OLEDs according to the present disclosure may include any of the other functional layers often found in OLEDs.

[0267] The enhancement layer can be comprised of plasmonic materials, optically active metamaterials, or hyperbolic metamaterials. As used herein, a plasmonic material is a material in which the real part of the dielectric constant crosses zero in the visible or ultraviolet region of the electromagnetic spectrum. In some embodiments, the plasmonic material includes at least one metal. In such embodiments the metal may include at least one of Ag, Al, Au, Ir, Pt, Ni, Cu, W, Ta, Fe, Cr, Mg, Ga, Rh, Ti, Ru, Pd, In, Bi, Ca alloys or mixtures of these materials, and stacks of these materials. In general, a metamaterial is a medium composed of different materials where the medium as a whole acts differently than the sum of its material parts. In particular, we define optically active metamaterials as materials which have both negative permittivity and negative permeability. Hyperbolic metamaterials, on the other hand, are anisotropic media in which the permittivity or permeability are of different sign for different spatial directions. Optically active metamaterials and hyperbolic metamaterials are strictly distinguished from many other photonic structures such as Distributed Bragg Reflectors (“DBRs”) in that the medium should appear uniform in the direction of propagation on the length scale of the wavelength of light. Using terminology that one skilled in the art can understand: the dielectric constant of the metamaterials in the direction of propagation can be described with the effective medium approximation. Plasmonic materials and metamaterials provide methods for controlling the propagation of light that can enhance OLED performance in a number of ways.

[0268] In some embodiments, the enhancement layer is provided as a planar layer. In other embodiments, the enhancement layer has wavelength-sized features that are arranged periodically, quasi-periodically, or randomly, or sub-wavelength-sized features that are arranged periodically, quasi-periodically, or randomly. In some embodiments, the wavelength-sized features and the sub-wavelength-sized features have sharp edges.

[0269] In some embodiments, the outcoupling layer has wavelength-sized features that are arranged periodically, quasi-periodically, or randomly, or sub-wavelength-sized features that are arranged periodically, quasi-periodically, or randomly. In some embodiments, the outcoupling layer may be composed of a plurality of nanoparticles and in other embodiments the outcoupling layer is composed of a plurality of nanoparticles disposed over a material. In these embodiments the outcoupling may be tunable by at least one of varying a size of the plurality of nanoparticles, varying a shape of the plurality of nanoparticles, changing a material of the plurality of nanoparticles, adjusting a thickness of the material, changing the refractive index of the material or an additional layer disposed on the plurality of nanoparticles, varying a thickness of the enhancement layer, and/or varying the material of the enhancement layer. The plurality of nanoparticles of the device may be formed from at least one of metal, dielectric material, semiconductor materials, an alloy of metal, a mixture of dielectric materials, a stack or layering of one or more materials, and/or a core of one type of material and that is coated with a shell of a different type of material. In some embodiments, the outcoupling layer is composed of at least metal nanoparticles wherein the metal is selected from the group consisting of Ag, Al, Au, Ir, Pt, Ni, Cu, W, Ta, Fe, Cr, Mg, Ga, Rh, Ti, Ru, Pd, In, Bi, Ca, alloys or mixtures of these materials, and stacks of these materials. The plurality of nanoparticles may have additional layer disposed over

them. In some embodiments, the polarization of the emission can be tuned using the outcoupling layer. Varying the dimensionality and periodicity of the outcoupling layer can select a type of polarization that is preferentially outcoupled to air. In some embodiments the outcoupling layer also acts as an electrode of the device.

[0270] In yet another aspect, the present disclosure also provides a consumer product comprising an organic light-emitting device (OLED) having an anode; a cathode; and an organic layer disposed between the anode and the cathode, wherein the organic layer may comprise a compound as disclosed in the above compounds section of the present disclosure.

[0271] In some embodiments, the consumer product comprises an OLED having an anode; a cathode; and an organic layer disposed between the anode and the cathode, wherein the organic layer may comprise a compound comprising a first ligand L.sub.A of Formula I as described herein.

[0272] In some embodiments, the consumer product can be one of a flat panel display, a computer monitor, a medical monitor, a television, a billboard, a light for interior or exterior illumination and/or signaling, a heads-up display, a fully or partially transparent display, a flexible display, a laser printer, a telephone, a cell phone, tablet, a phablet, a personal digital assistant (PDA), a wearable device, a laptop computer, a digital camera, a camcorder, a viewfinder, a micro-display that is less than 2 inches diagonal, a 3-D display, a virtual reality or augmented reality display, a vehicle, a video wall comprising multiple displays tiled together, a theater or stadium screen, a light therapy device, and a sign.

[0273] Generally, an OLED comprises at least one organic layer disposed between and electrically connected to an anode and a cathode. When a current is applied, the anode injects holes and the cathode injects electrons into the organic layer(s). The injected holes and electrons each migrate toward the oppositely charged electrode. When an electron and hole localize on the same molecule, an “exciton,” which is a localized electron-hole pair having an excited energy state, is formed. Light is emitted when the exciton relaxes via a photoemissive mechanism. In some cases, the exciton may be localized on an excimer or an exciplex. Non-radiative mechanisms, such as thermal relaxation, may also occur, but are generally considered undesirable.

[0274] Several OLED materials and configurations are described in U.S. Pat. Nos. 5,844,363, 6,303,238, and 5,707,745, which are incorporated herein by reference in their entirety.

[0275] The initial OLEDs used emissive molecules that emitted light from their singlet states (“fluorescence”) as disclosed, for example, in U.S. Pat. No. 4,769,292, which is incorporated by reference in its entirety. Fluorescent emission generally occurs in a time frame of less than 10 nanoseconds.

[0276] More recently, OLEDs having emissive materials that emit light from triplet states (“phosphorescence”) have been demonstrated. Baldo et al., “Highly Efficient Phosphorescent Emission from Organic Electroluminescent Devices,” *Nature*, vol. 395, 151-154, 1998; (“Baldo-I”) and Baldo et al., “Very high-efficiency green organic light-emitting devices based on electrophosphorescence,” *Appl. Phys. Lett.*, vol. 75, No. 3, 4-6 (1999) (“Baldo-II”), are incorporated by reference in their entireties. Phosphorescence is described in more detail in U.S. Pat. No. 7,279,704 at cols. 5-6, which are incorporated by reference.

[0277] FIG. 1 shows an organic light emitting device **100**. The figures are not necessarily drawn to scale. Device **100** may include a substrate **110**, an anode **115**, a hole injection layer **120**, a hole transport layer **125**, an electron blocking layer **130**, an emissive layer **135**, a hole blocking layer **140**, an electron transport layer **145**, an electron injection layer **150**, a protective layer **155**, a cathode **160**, and a barrier layer **170**. Cathode **160** is a compound cathode having a first conductive layer **162** and a second conductive layer **164**. Device **100** may be fabricated by depositing the layers described, in order. The properties and functions of these various layers, as well as example materials, are described in more detail in U.S. Pat. No. 7,279,704 at cols. 6-10, which are incorporated by reference.

[0278] More examples for each of these layers are available. For example, a flexible and transparent substrate-anode combination is disclosed in U.S. Pat. No. 5,844,363, which is incorporated by reference in its entirety. An example of a p-doped hole transport layer is m-MTDATA doped with F.sub.4-TCNQ at a molar ratio of 50:1, as disclosed in U.S. Patent Application Publication No. 2003/0230980, which is incorporated by reference in its entirety. Examples of emissive and host materials are disclosed in U.S. Pat. No. 6,303,238 to Thompson et al., which is incorporated by reference in its entirety. An example of an n-doped electron transport layer is BPhen doped with Li at a molar ratio of 1:1, as disclosed in U.S. Patent Application Publication No. 2003/0230980, which is incorporated by reference in its entirety. U.S. Pat. Nos. 5,703,436 and 5,707,745, which are incorporated by reference in their entireties, disclose examples of cathodes including compound cathodes having a thin layer of metal such as Mg:Ag with an overlying transparent, electrically-conductive, sputter-deposited ITO layer. The theory and use of blocking layers is described in more detail in U.S. Pat. No. 6,097,147 and U.S. Patent Application Publication No. 2003/0230980, which are incorporated by reference in their entireties. Examples of injection layers are provided in U.S. Patent Application Publication No. 2004/0174116, which is incorporated by reference in its entirety. A description of protective layers may be found in U.S. Patent Application Publication No. 2004/0174116, which is incorporated by reference in its entirety.

[0279] FIG. 2 shows an inverted OLED **200**. The device includes a substrate **210**, a cathode **215**, an emissive layer **220**, a hole transport layer **225**, and an anode **230**. Device **200** may be fabricated by depositing the layers described, in order. Because the most common OLED configuration has a cathode disposed over the anode, and device **200** has cathode **215** disposed under anode **230**, device **200** may be referred to as an “inverted” OLED. Materials similar to those described with respect to device **100** may be used in the corresponding layers of device **200**. FIG. 2 provides one example of how some layers may be omitted from the structure of device **100**.

[0280] The simple layered structure illustrated in FIGS. 1 and 2 is provided by way of non-limiting example, and it is understood that embodiments of the present disclosure may be used in connection with a wide variety of other structures. The specific materials and structures described are exemplary in nature, and other materials and structures may be used. Functional OLEDs may be achieved by combining the various layers described in different ways, or layers may be omitted entirely, based on design, performance, and cost factors. Other layers not specifically described may also be included. Materials other than those specifically described may be used. Although many of the examples provided herein describe various layers as comprising a single material, it is understood that combinations of materials, such as a mixture of host and dopant, or more generally a mixture, may be used. Also, the layers may have various sublayers. The names given to the various layers herein are not intended to be strictly limiting. For example, in device **200**, hole transport layer **225** transports holes and injects holes into emissive layer **220**, and may be described as a hole transport layer or a hole injection layer. In one embodiment, an OLED may be described as having an “organic layer” disposed between a cathode and an anode. This organic layer may comprise a single layer, or may further comprise multiple layers of different organic materials as described, for example, with respect to FIGS. 1 and 2.

[0281] Structures and materials not specifically described may also be used, such as OLEDs comprised of polymeric materials (PLEDs) such as disclosed in U.S. Pat. No. 5,247,190 to Friend et al., which is incorporated by reference in its entirety. By way of further example, OLEDs having a single organic layer may be used. OLEDs may be stacked, for example as described in U.S. Pat. No. 5,707,745 to Forrest et al, which is incorporated by reference in its entirety. The OLED structure may deviate from the simple layered structure illustrated in FIGS. 1 and 2. For example, the substrate may include an angled reflective surface to improve out-coupling, such as a mesa structure as described in U.S. Pat. No. 6,091,195 to Forrest et al., and/or a pit structure as described in U.S. Pat. No. 5,834,893 to Bulovic et al., which are incorporated by reference in their entireties.

[0282] Unless otherwise specified, any of the layers of the various embodiments may be deposited by any suitable method. For the organic layers, preferred methods include thermal evaporation, ink-jet, such as described in U.S. Pat. Nos. 6,013,982 and 6,087,196, which are incorporated by reference in their entireties, organic vapor phase deposition (OVPD), such as described in U.S. Pat. No. 6,337,102 to Forrest et al., which is incorporated by reference in its entirety, and deposition by organic vapor jet printing (OVJP, also referred to as organic vapor jet deposition (OVJD)), such as described in U.S. Pat. No. 7,431,968, which is incorporated by reference in its entirety. Other suitable deposition methods include spin coating and other solution based processes. Solution based processes are preferably carried out in nitrogen or an inert atmosphere. For the other layers, preferred methods include thermal evaporation. Preferred patterning methods include deposition through a mask, cold welding such as described in U.S. Pat. Nos. 6,294,398 and 6,468,819, which are incorporated by reference in their entireties, and patterning associated with some of the deposition methods such as ink-jet and organic vapor jet printing (OVJP). Other methods may also be used. The materials to be deposited may be modified to make them compatible with a particular deposition method. For example, substituents such as alkyl and aryl groups, branched or unbranched, and preferably containing at least 3 carbons, may be used in small molecules to enhance their ability to undergo solution processing. Substituents having 20 carbons or more may be used, and 3-20 carbons are a preferred range. Materials with asymmetric structures may have better solution processability than those having symmetric structures, because asymmetric materials may have a lower tendency to recrystallize. Dendrimer substituents may be used to enhance the ability of small molecules to undergo solution processing.

[0283] Devices fabricated in accordance with embodiments of the present disclosure may further optionally comprise a barrier layer. One purpose of the barrier layer is to protect the electrodes and organic layers from damaging exposure to harmful species in the environment including moisture, vapor and/or gases, etc. The barrier layer may be deposited over, under or next to a substrate, an electrode, or over any other parts of a device including an edge. The barrier layer may comprise a single layer, or multiple layers. The barrier layer may be formed by various known chemical vapor deposition techniques and may include compositions having a single phase as well as compositions having multiple phases. Any suitable material or combination of materials may be used for the barrier layer. The barrier layer may incorporate an inorganic or an organic compound or both. The preferred barrier layer comprises a mixture of a polymeric material and a non-polymeric material as described in U.S. Pat. No. 7,968,146, PCT Pat. Application Nos. PCT/US2007/023098 and PCT/US2009/042829, which are herein incorporated by reference in their entireties. To be considered a "mixture", the aforesaid polymeric and non-polymeric materials comprising the barrier layer should be deposited under the same reaction conditions and/or at the same time. The weight ratio of polymeric to non-polymeric material may be in the range of 95:5 to 5:95. The polymeric material and the non-polymeric material may be created from the same precursor material. In one example, the mixture of a polymeric material and a non-polymeric material consists essentially of polymeric silicon and inorganic silicon.

[0284] Devices fabricated in accordance with embodiments of the present disclosure can be incorporated into a wide variety of electronic component modules (or units) that can be incorporated into a variety of electronic products or intermediate components. Examples of such electronic products or intermediate components include display screens, lighting devices such as discrete light source devices or lighting panels, etc. that can be utilized by the end-user product manufacturers. Such electronic component modules can optionally include the driving electronics and/or power source(s). Devices fabricated in accordance with embodiments of the present disclosure can be incorporated into a wide variety of consumer products that have one or more of the electronic component modules (or units) incorporated therein. A consumer product comprising an OLED that includes the compound of the present disclosure in the organic layer in the OLED is disclosed. Such consumer products would include any kind of products that include one or more

light source(s) and/or one or more of some type of visual displays. Some examples of such consumer products include flat panel displays, curved displays, computer monitors, medical monitors, televisions, billboards, lights for interior or exterior illumination and/or signaling, heads-up displays, fully or partially transparent displays, flexible displays, rollable displays, foldable displays, stretchable displays, laser printers, telephones, mobile phones, tablets, phablets, personal digital assistants (PDAs), wearable devices, laptop computers, digital cameras, camcorders, viewfinders, micro-displays (displays that are less than 2 inches diagonal), 3-D displays, virtual reality or augmented reality displays, vehicles, video walls comprising multiple displays tiled together, theater or stadium screen, a light therapy device, and a sign. Various control mechanisms may be used to control devices fabricated in accordance with the present disclosure, including passive matrix and active matrix. Many of the devices are intended for use in a temperature range comfortable to humans, such as 18 degrees C. to 30 degrees C., and more preferably at room temperature (20-25° C.), but could be used outside this temperature range, for example, from -40 degree C. to +80° C.

[0285] More details on OLEDs, and the definitions described above, can be found in U.S. Pat. No. 7,279,704, which is incorporated herein by reference in its entirety.

[0286] The materials and structures described herein may have applications in devices other than OLEDs. For example, other optoelectronic devices such as organic solar cells and organic photodetectors may employ the materials and structures. More generally, organic devices, such as organic transistors, may employ the materials and structures.

[0287] In some embodiments, the OLED has one or more characteristics selected from the group consisting of being flexible, being rollable, being foldable, being stretchable, and being curved. In some embodiments, the OLED is transparent or semi-transparent. In some embodiments, the OLED further comprises a layer comprising carbon nanotubes.

[0288] In some embodiments, the OLED further comprises a layer comprising a delayed fluorescent emitter. In some embodiments, the OLED comprises a RGB pixel arrangement or white plus color filter pixel arrangement. In some embodiments, the OLED is a mobile device, a hand held device, or a wearable device. In some embodiments, the OLED is a display panel having less than 10 inch diagonal or 50 square inch area. In some embodiments, the OLED is a display panel having at least 10 inch diagonal or 50 square inch area. In some embodiments, the OLED is a lighting panel.

[0289] In some embodiments, the compound can be an emissive dopant. In some embodiments, the compound can produce emissions via phosphorescence, fluorescence, thermally activated delayed fluorescence, i.e., TADF (also referred to as E-type delayed fluorescence; see, e.g., U.S. application Ser. No. 15/700,352, which is hereby incorporated by reference in its entirety), triplet-triplet annihilation, or combinations of these processes. In some embodiments, the emissive dopant can be a racemic mixture, or can be enriched in one enantiomer. In some embodiments, the compound can be homoleptic (each ligand is the same). In some embodiments, the compound can be heteroleptic (at least one ligand is different from others). When there are more than one ligand coordinated to a metal, the ligands can all be the same in some embodiments. In some other embodiments, at least one ligand is different from the other ligands. In some embodiments, every ligand can be different from each other. This is also true in embodiments where a ligand being coordinated to a metal can be linked with other ligands being coordinated to that metal to form a tridentate, tetradentate, pentadentate, or hexadentate ligands. Thus, where the coordinating ligands are being linked together, all of the ligands can be the same in some embodiments, and at least one of the ligands being linked can be different from the other ligand(s) in some other embodiments.

[0290] In some embodiments, the compound can be used as a phosphorescent sensitizer in an OLED where one or multiple layers in the OLED contains an acceptor in the form of one or more fluorescent and/or delayed fluorescence emitters. In some embodiments, the compound can be used as one component of an exciplex to be used as a sensitizer. As a phosphorescent sensitizer, the

compound must be capable of energy transfer to the acceptor and the acceptor will emit the energy or further transfer energy to a final emitter. The acceptor concentrations can range from 0.001% to 100%. The acceptor could be in either the same layer as the phosphorescent sensitizer or in one or more different layers. In some embodiments, the acceptor is a TADF emitter. In some embodiments, the acceptor is a fluorescent emitter. In some embodiments, the emission can arise from any or all of the sensitizer, acceptor, and final emitter

[0291] According to another aspect, a formulation comprising the compound described herein is also disclosed.

[0292] The OLED disclosed herein can be incorporated into one or more of a consumer product, an electronic component module, and a lighting panel. The organic layer can be an emissive layer and the compound can be an emissive dopant in some embodiments, while the compound can be a non-emissive dopant in other embodiments.

[0293] In yet another aspect of the present disclosure, a formulation that comprises the novel compound disclosed herein is described. The formulation can include one or more components selected from the group consisting of a solvent, a host, a hole injection material, hole transport material, electron blocking material, hole blocking material, and an electron transport material, disclosed herein.

[0294] The present disclosure encompasses any chemical structure comprising the novel compound of the present disclosure, or a monovalent or polyvalent variant thereof. In other words, the inventive compound, or a monovalent or polyvalent variant thereof, can be a part of a larger chemical structure. Such chemical structure can be selected from the group consisting of a monomer, a polymer, a macromolecule, and a supramolecule (also known as supermolecule). As used herein, a “monovalent variant of a compound” refers to a moiety that is identical to the compound except that one hydrogen has been removed and replaced with a bond to the rest of the chemical structure. As used herein, a “polyvalent variant of a compound” refers to a moiety that is identical to the compound except that more than one hydrogen has been removed and replaced with a bond or bonds to the rest of the chemical structure. In the instance of a supramolecule, the inventive compound can also be incorporated into the supramolecule complex without covalent bonds.

D. Combination of the Compounds of the Present Disclosure with Other Materials

[0295] The materials described herein as useful for a particular layer in an organic light emitting device may be used in combination with a wide variety of other materials present in the device. For example, emissive dopants disclosed herein may be used in conjunction with a wide variety of hosts, transport layers, blocking layers, injection layers, electrodes and other layers that may be present. The materials described or referred to below are non-limiting examples of materials that may be useful in combination with the compounds disclosed herein, and one of skill in the art can readily consult the literature to identify other materials that may be useful in combination.

a) Conductivity Dopants:

[0296] A charge transport layer can be doped with conductivity dopants to substantially alter its density of charge carriers, which will in turn alter its conductivity. The conductivity is increased by generating charge carriers in the matrix material, and depending on the type of dopant, a change in the Fermi level of the semiconductor may also be achieved. Hole-transporting layer can be doped by p-type conductivity dopants and n-type conductivity dopants are used in the electron-transporting layer.

[0297] Non-limiting examples of the conductivity dopants that may be used in an OLED in combination with materials disclosed herein are exemplified below together with references that disclose those materials: EP01617493, EP01968131, EP2020694, EP2684932, US20050139810, US20070160905, US20090167167, US2010288362, WO06081780, WO2009003455, WO2009008277, WO2009011327, WO2014009310, US2007252140, US2015060804, US20150123047, and US2012146012.

##STR00510## ##STR00511##

b) HIL/HTL:

[0298] A hole injecting/transporting material to be used in the present disclosure is not particularly limited, and any compound may be used as long as the compound is typically used as a hole injecting/transporting material. Examples of the material include, but are not limited to: a phthalocyanine or porphyrin derivative; an aromatic amine derivative; an indolocarbazole derivative; a polymer containing fluorohydrocarbon; a polymer with conductivity dopants; a conducting polymer, such as PEDOT/PSS; a self-assembly monomer derived from compounds such as phosphonic acid and silane derivatives; a metal oxide derivative, such as MoO₃; a p-type semiconducting organic compound, such as 1,4,5,8,9,12-

Hexaazatriphenylenehexacarbonitrile; a metal complex, and a cross-linkable compounds.

[0299] Examples of aromatic amine derivatives used in HIL or HTL include, but not limit to the following general structures:

##STR00512##

[0300] Each of Ar^{sup.1} to Ar^{sup.9} is selected from the group consisting of aromatic hydrocarbon cyclic compounds such as benzene, biphenyl, triphenyl, triphenylene, naphthalene, anthracene, phenalene, phenanthrene, fluorene, pyrene, chrysene, perylene, and azulene; the group consisting of aromatic heterocyclic compounds such as dibenzothiophene, dibenzofuran, dibenzoselenophene, furan, thiophene, benzofuran, benzothiophene, benzoselenophene, carbazole, indolocarbazole, pyridylindole, pyrrolodipyridine, pyrazole, imidazole, triazole, oxazole, thiazole, oxadiazole, oxatriazole, dioxazole, thiadiazole, pyridine, pyridazine, pyrimidine, pyrazine, triazine, oxazine, oxathiazine, oxadiazine, indole, benzimidazole, indazole, indoxazine, benzoxazole, benzisoxazole, benzothiazole, quinoline, isoquinoline, cinnoline, quinazoline, quinoxaline, naphthyridine, phthalazine, pteridine, xanthene, acridine, phenazine, phenothiazine, phenoxazine, benzofuropyridine, furodipyridine, benzothienopyridine, thienodipyridine, benzoselenophenopyridine, and selenophenodipyridine; and the group consisting of 2 to 10 cyclic structural units which are groups of the same type or different types selected from the aromatic hydrocarbon cyclic group and the aromatic heterocyclic group and are bonded to each other directly or via at least one of oxygen atom, nitrogen atom, sulfur atom, silicon atom, phosphorus atom, boron atom, chain structural unit and the aliphatic cyclic group. Each Ar may be unsubstituted or may be substituted by a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acids, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, and combinations thereof.

[0301] In one aspect, Ar^{sup.1} to Ar^{sup.9} is independently selected from the group consisting of:

##STR00513##

wherein k is an integer from 1 to 20; X^{sup.101} to X^{sup.108} is C (including CH) or N; Z^{sup.101} is NAr^{sup.1}, O, or S; Ar^{sup.1} has the same group defined above.

[0302] Examples of metal complexes used in HIL or HTL include, but are not limited to the following general formula:

##STR00514##

wherein Met is a metal, which can have an atomic weight greater than 40; (Y^{sup.101}-Y^{sup.102}) is a bidentate ligand, Y^{sup.101} and Y^{sup.102} are independently selected from C, N, O, P, and S; L^{sup.101} is an ancillary ligand; k' is an integer value from 1 to the maximum number of ligands that may be attached to the metal; and k'+k'' is the maximum number of ligands that may be attached to the metal.

[0303] In one aspect, (Y^{sup.101}-Y^{sup.102}) is a 2-phenylpyridine derivative. In another aspect, (Y^{sup.101}-Y^{sup.102}) is a carbene ligand. In another aspect, Met is selected from Ir, Pt, Os, and Zn. In a further aspect, the metal complex has a smallest oxidation potential in solution vs. Fc^{sup.+}/Fc couple less than about 0.6 V.

[0304] Non-limiting examples of the HIL and HTL materials that may be used in an OLED in combination with materials disclosed herein are exemplified below together with references that disclose those materials: CN102702075, DE102012005215, EP01624500, EP01698613, EP01806334, EP01930964, EP01972613, EP01997799, EP02011790, EP02055700, EP02055701, EP1725079, EP2085382, EP2660300, EP650955, JP07-073529, JP2005112765, JP2007091719, JP2008021687, JP2014-009196, KR20110088898, KR20130077473, TW201139402, U.S. Ser. No. 06/517,957, US20020158242, US20030162053, US20050123751, US20060182993, US20060240279, US20070145888, US20070181874, US20070278938, US20080014464, US20080091025, US20080106190, US20080124572, US20080145707, US20080220265, US20080233434, US20080303417, US2008107919, US20090115320, US20090167161, US2009066235, US2011007385, US20110163302, US2011240968, US2011278551, US2012205642, US2013241401, US20140117329, US2014183517, U.S. Pat. Nos. 5,061,569, 5,639,914, WO05075451, WO07125714, WO08023550, WO08023759, WO2009145016, WO2010061824, WO2011075644, WO2012177006, WO2013018530, WO2013039073, WO2013087142, WO2013118812, WO2013120577, WO2013157367, WO2013175747, WO2014002873, WO2014015935, WO2014015937, WO2014030872, WO2014030921, WO2014034791, WO2014104514, WO2014157018.

##STR00515## ##STR00516## ##STR00517## ##STR00518## ##STR00519## ##STR00520##
##STR00521## ##STR00522## ##STR00523## ##STR00524## ##STR00525## ##STR00526##
##STR00527## ##STR00528##

c) EBL:

[0305] An electron blocking layer (EBL) may be used to reduce the number of electrons and/or excitons that leave the emissive layer. The presence of such a blocking layer in a device may result in substantially higher efficiencies, and/or longer lifetime, as compared to a similar device lacking a blocking layer. Also, a blocking layer may be used to confine emission to a desired region of an OLED. In some embodiments, the EBL material has a higher LUMO (closer to the vacuum level) and/or higher triplet energy than the emitter closest to the EBL interface. In some embodiments, the EBL material has a higher LUMO (closer to the vacuum level) and/or higher triplet energy than one or more of the hosts closest to the EBL interface. In one aspect, the compound used in EBL contains the same molecule or the same functional groups used as one of the hosts described below.

d) Hosts:

[0306] The light emitting layer of the organic EL device of the present disclosure preferably contains at least a metal complex as light emitting material, and may contain a host material using the metal complex as a dopant material. Examples of the host material are not particularly limited, and any metal complexes or organic compounds may be used as long as the triplet energy of the host is larger than that of the dopant. Any host material may be used with any dopant so long as the triplet criteria is satisfied.

[0307] Examples of metal complexes used as host are preferred to have the following general formula:

##STR00529##

wherein Met is a metal; (Y.sup.103-Y.sup.104) is a bidentate ligand, Y.sup.103 and Y.sup.104 are independently selected from C, N, O, P, and S; L.sup.101 is an another ligand; k' is an integer value from 1 to the maximum number of ligands that may be attached to the metal; and k'+k'' is the maximum number of ligands that may be attached to the metal.

[0308] In one aspect, the metal complexes are:

##STR00530##

wherein (O—N) is a bidentate ligand, having metal coordinated to atoms O and N.

[0309] In another aspect, Met is selected from Ir and Pt. In a further aspect, (Y.sup.103-Y.sup.104) is a carbene ligand.

[0310] In one aspect, the host compound contains at least one of the following groups selected

from the group consisting of aromatic hydrocarbon cyclic compounds such as benzene, biphenyl, triphenyl, triphenylene, tetraphenylene, naphthalene, anthracene, phenalene, phenanthrene, fluorene, pyrene, chrysene, perylene, and azulene; the group consisting of aromatic heterocyclic compounds such as dibenzothiophene, dibenzofuran, dibenzoselenophene, furan, thiophene, benzofuran, benzothiophene, benzoselenophene, carbazole, indolocarbazole, pyridylindole, pyrrolodipyridine, pyrazole, imidazole, triazole, oxazole, thiazole, oxadiazole, oxatriazole, dioxazole, thiadiazole, pyridine, pyridazine, pyrimidine, pyrazine, triazine, oxazine, oxathiazine, oxadiazine, indole, benzimidazole, indazole, indoxazine, benzoxazole, benzisoxazole, benzothiazole, quinoline, isoquinoline, cinnoline, quinazoline, quinoxaline, naphthyridine, phthalazine, pteridine, xanthene, acridine, phenazine, phenothiazine, phenoxazine, benzofuropyridine, furodipyridine, benzothienopyridine, thienodipyridine, benzoselenophenopyridine, and selenophenodipyridine; and the group consisting of 2 to 10 cyclic structural units which are groups of the same type or different types selected from the aromatic hydrocarbon cyclic group and the aromatic heterocyclic group and are bonded to each other directly or via at least one of oxygen atom, nitrogen atom, sulfur atom, silicon atom, phosphorus atom, boron atom, chain structural unit and the aliphatic cyclic group. Each option within each group may be unsubstituted or may be substituted by a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acids, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, and combinations thereof.

[0311] In one aspect, the host compound contains at least one of the following groups in the molecule:

##STR00531## ##STR00532##

wherein R^{sup.101} is selected from the group consisting of hydrogen, deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acids, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, and combinations thereof, and when it is aryl or heteroaryl, it has the similar definition as Ar's mentioned above. k is an integer from 0 to 20 or 1 to 20. X^{sup.101} to X^{sup.108} are independently selected from C (including CH) or N. Z^{sup.101} and Z^{sup.102} are independently selected from NR^{sup.101}, O, or S.

[0312] Non-limiting examples of the host materials that may be used in an OLED in combination with materials disclosed herein are exemplified below together with references that disclose those materials: EP2034538, EP2034538A, EP2757608, JP2007254297, KR20100079458, KR20120088644, KR20120129733, KR20130115564, TW201329200, US20030175553, US20050238919, US20060280965, US20090017330, US20090030202, US20090167162, US20090302743, US20090309488, US20100012931, US20100084966, US20100187984, US2010187984, US2012075273, US2012126221, US2013009543, US2013105787, US2013175519, US2014001446, US20140183503, US20140225088, US2014034914, U.S. Pat. No. 7,154,114, WO2001039234, WO2004093207, WO2005014551, WO2005089025, WO2006072002, WO2006114966, WO2007063754, WO2008056746, WO2009003898, WO2009021126, WO2009063833, WO2009066778, WO2009066779, WO2009086028, WO2010056066, WO2010107244, WO2011081423, WO2011081431, WO2011086863, WO2012128298, WO2012133644, WO2012133649, WO2013024872, WO2013035275, WO2013081315, WO2013191404, WO2014142472, US20170263869, US20160163995, U.S. Pat. No. 9,466,803,

##STR00533## ##STR00534## ##STR00535## ##STR00536## ##STR00537## ##STR00538## ##STR00539## ##STR00540## ##STR00541## ##STR00542## ##STR00543##

e) Additional Emitters:

[0313] One or more additional emitter dopants may be used in conjunction with the compound of

the present disclosure. Examples of the additional emitter dopants are not particularly limited, and any compounds may be used as long as the compounds are typically used as emitter materials. Examples of suitable emitter materials include, but are not limited to, compounds which can produce emissions via phosphorescence, fluorescence, thermally activated delayed fluorescence, i.e., TADF (also referred to as E-type delayed fluorescence), triplet-triplet annihilation, or combinations of these processes.

Non-limiting examples of the emitter materials that may be used in an OLED in combination with materials disclosed herein are exemplified below together with references that disclose those materials: CN103694277, CN1696137, EB01238981, EP01239526, EP01961743, EP1239526, EP1244155, EP1642951, EP1647554, EP1841834, EP1841834B, EP2062907, EP2730583, JP2012074444, JP2013110263, JP4478555, KR1020090133652, KR20120032054, KR20130043460, TW201332980, U.S. Ser. No. 06/699,599, U.S. Ser. No. 06/916,554, US20010019782, US20020034656, US20030068526, US20030072964, US20030138657, US20050123788, US20050244673, US2005123791, US2005260449, US20060008670, US20060065890, US20060127696, US20060134459, US20060134462, US20060202194, US20060251923, US20070034863, US20070087321, US20070103060, US20070111026, US20070190359, US20070231600, US2007034863, US2007104979, US2007104980, US2007138437, US2007224450, US2007278936, US20080020237, US20080233410, US20080261076, US20080297033, US200805851, US2008161567, US2008210930, US20090039776, US20090108737, US20090115322, US20090179555, US2009085476, US2009104472, US20100090591, US20100148663, US20100244004, US20100295032, US2010102716, US2010105902, US2010244004, US2010270916, US20110057559, US20110108822, US20110204333, US2011215710, US2011227049, US2011285275, US2012292601, US20130146848, US2013033172, US2013165653, US2013181190, US2013334521, US20140246656, US2014103305, U.S. Pat. Nos. 6,303,238, 6,413,656, 6,653,654, 6,670,645, 6,687,266, 6,835,469, 6,921,915, 7,279,704, 7,332,232, 7,378,162, 7,534,505, 7,675,228, 7,728,137, 7,740,957, 7,759,489, 7,951,947, 8,067,099, 8,592,586, 8,871,361, WO06081973, WO06121811, WO07018067, WO07108362, WO07115970, WO07115981, WO08035571, WO2002015645, WO2003040257, WO2005019373, WO2006056418, WO2008054584, WO2008078800, WO2008096609, WO2008101842, WO2009000673, WO2009050281, WO2009100991, WO2010028151, WO2010054731, WO2010086089, WO2010118029, WO2011044988, WO2011051404, WO2011107491, WO2012020327, WO2012163471, WO2013094620, WO2013107487, WO2013174471, WO2014007565, WO2014008982, WO2014023377, WO2014024131, WO2014031977, WO2014038456, WO2014112450.

##STR00544## ##STR00545## ##STR00546## ##STR00547## ##STR00548## ##STR00549##
##STR00550## ##STR00551## ##STR00552## ##STR00553##

f) HBL:

[0314] A hole blocking layer (HBL) may be used to reduce the number of holes and/or excitons that leave the emissive layer. The presence of such a blocking layer in a device may result in substantially higher efficiencies and/or longer lifetime as compared to a similar device lacking a blocking layer. Also, a blocking layer may be used to confine emission to a desired region of an OLED. In some embodiments, the HBL material has a lower HOMO (further from the vacuum level) and/or higher triplet energy than the emitter closest to the HBL interface. In some embodiments, the HBL material has a lower HOMO (further from the vacuum level) and/or higher triplet energy than one or more of the hosts closest to the HBL interface.

[0315] In one aspect, compound used in HBL contains the same molecule or the same functional groups used as host described above.

[0316] In another aspect, compound used in HBL contains at least one of the following groups in the molecule:

##STR00554##

wherein k is an integer from 1 to 20; L.sup.101 is another ligand, k' is an integer from 1 to 3.

g) ETL:

[0317] Electron transport layer (ETL) may include a material capable of transporting electrons. Electron transport layer may be intrinsic (undoped), or doped. Doping may be used to enhance conductivity. Examples of the ETL material are not particularly limited, and any metal complexes or organic compounds may be used as long as they are typically used to transport electrons.

[0318] In one aspect, compound used in ETL contains at least one of the following groups in the molecule:

##STR00555##

wherein R.sup.101 is selected from the group consisting of hydrogen, deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acids, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, and combinations thereof, when it is aryl or heteroaryl, it has the similar definition as Ar's mentioned above. Ar.sup.1 to Ar.sup.3 has the similar definition as Ar's mentioned above. k is an integer from 1 to 20. X.sup.101 to X.sup.108 is selected from C (including CH) or N.

[0319] In another aspect, the metal complexes used in ETL contains, but not limit to the following general formula:

##STR00556##

wherein (O—N) or (N—N) is a bidentate ligand, having metal coordinated to atoms O, N or N, N; L.sup.101 is another ligand; k' is an integer value from 1 to the maximum number of ligands that may be attached to the metal.

[0320] Non-limiting examples of the ETL materials that may be used in an OLED in combination with materials disclosed herein are exemplified below together with references that disclose those materials: CN103508940, EP01602648, EP01734038, EP01956007, JP2004-022334, JP2005149918, JP2005-268199, KR0117693, KR20130108183, US20040036077, US20070104977, US2007018155, US20090101870, US20090115316, US20090140637, US20090179554, US2009218940, US2010108990, US2011156017, US2011210320, US2012193612, US2012214993, US2014014925, US2014014927, US20140284580, U.S. Pat. Nos. 6,656,612, 8,415,031, WO2003060956, WO2007111263, WO2009148269, WO2010067894, WO2010072300, WO2011074770, WO2011105373, WO2013079217, WO2013145667, WO2013180376, WO2014104499, WO2014104535,

##STR00557## ##STR00558## ##STR00559## ##STR00560## ##STR00561## ##STR00562## ##STR00563## ##STR00564## ##STR00565## ##STR00566##

h) Charge Generation Layer (CGL)

[0321] In tandem or stacked OLEDs, the CGL plays an essential role in the performance, which is composed of an n-doped layer and a p-doped layer for injection of electrons and holes, respectively. Electrons and holes are supplied from the CGL and electrodes. The consumed electrons and holes in the CGL are refilled by the electrons and holes injected from the cathode and anode, respectively; then, the bipolar currents reach a steady state gradually. Typical CGL materials include n and p conductivity dopants used in the transport layers.

[0322] In any above-mentioned compounds used in each layer of the OLED device, the hydrogen atoms can be partially or fully deuterated. The minimum amount of hydrogen of the compound being deuterated is selected from the group consisting of 30%, 40%, 50%, 60%, 70%, 80%, 90%, 95%, 99%, and 100%. Thus, any specifically listed substituent, such as, without limitation, methyl, phenyl, pyridyl, etc. may be undeuterated, partially deuterated, and fully deuterated versions thereof. Similarly, classes of substituents such as, without limitation, alkyl, aryl, cycloalkyl, heteroaryl, etc. also may be undeuterated, partially deuterated, and fully deuterated versions thereof.

[0323] It is understood that the various embodiments described herein are by way of example only and are not intended to limit the scope of the invention. For example, many of the materials and structures described herein may be substituted with other materials and structures without deviating from the spirit of the invention. The present invention as claimed may therefore include variations from the particular examples and preferred embodiments described herein, as will be apparent to one of skill in the art. It is understood that various theories as to why the invention works are not intended to be limiting.

E. Experimental Data

##STR00567##

[0324] A solution of 6-isobutyl-4-(4-(triethylsilyl)naphthalen-2-yl)benzo-[4,5]thieno[3,2-d]pyrimidine (3.30 g, 6.84 mmol, 4.0 equiv) in dichlorobenzene (53 mL) was sparged with nitrogen for 10 minutes. 1,5-Cyclo-octadieneiridium(I) chloride dimer (1.15 g, 1.71 mmol, 1.0 equiv) was added then the reaction mixture heated at 134° C. for 7 days. The reaction mixture was cooled to room temperature, potassium (Z)-3,7-diethyl-6-oxonon-4-en-4-olate (1.28 g, 5.11 mmol, 3.0 equiv) and dichloromethane (17 mL) added then the reaction mixture heated at 44° C. for 1 hour.

Dichloromethane was removed under reduced pressure and the residue was loaded directly onto a Biotage automated chromatography system eluting with 3% ethyl acetate in hexanes to give bis[(6-isobutyl-4-(4-(triethylsilyl)naphthalen-2-yl)-1'-yl)benzo[4,5]thieno[3,2-d]-pyrimidin-3-yl]-[3,7-diethylnonane-4,6-dione-η.sub.2O,O']iridium(III) (1.476 g, 63% yield) as a red solid.

Device Examples

[0325] All example devices were fabricated by high vacuum (<10^{sup.}-7 Torr) thermal evaporation. The anode electrode was 1,200 Å of indium tin oxide (ITO). The cathode consisted of 10 Å of Liq (8-hydroxyquinoline lithium) followed by 1,000 Å of Al. All devices were encapsulated with a glass lid sealed with an epoxy resin in a nitrogen glove box (<1 ppm of H.sub.2O and O.sub.2) immediately after fabrication, and a moisture getter was incorporated inside the package. The organic stack of the device examples consisted of sequentially, from the ITO surface, 100 Å of LG101 (purchased from LG Chem) as the hole injection layer (HIL); 400 Å of HTM as a hole transporting layer (HTL); 50 Å of EBM as a electron blocking layer (EBL); 400 Å of an emissive layer (EML) containing RH and 3% of emitter, and 350 Å of Liq (8-hydroxyquinolinelithium) doped with 35% of ETM as the electron transporting layer (ETL). Table 1 shows the thickness of the device layers and materials.

TABLE-US-00004 TABLE 1 Device layer materials and thicknesses

Thickness	Layer	Material
1,200	Anode	ITO
100	HIL	LG101
400	HTL	HTM
50	EBL	EBM
400	EML	RH
350	ETL	Liq: ETM 35%
10	Cathode	Al

[0326] The chemical structures of the device materials are shown below:

##STR00568## ##STR00569##

[0327] Upon fabrication devices have been EL and JVL tested. For this purpose, the sample was energized by the 2 channel Keysight B2902A SMU at a current density of 10 mA/cm^{sup.2} and measured by the Photo Research PR735 Spectroradiometer. Radiance (W/str/cm^{sup.2}) from 380 nm to 1080 nm, and total integrated photon count were collected. The device is then placed under a large area silicon photodiode for the JVL sweep. The integrated photon count of the device at 10 mA/cm^{sup.2} is used to convert the photodiode current to photon count. The voltage is swept from 0 to a voltage equating to 200 mA/cm^{sup.2}. The EQE of the device is calculated using the total integrated photon count. All results are summarized in Table 2. Voltage, EQE, and LE of inventive example are reported as relative numbers normalized to the results of the comparative example.

TABLE-US-00005 TABLE 2 At 10 mA/cm^{sup.2} Red λ max FWHM Voltage EQE Device emitter

[nm]	[nm]	[V]	[%]	LE
Device Inventive	623	37	1.00	1.05
1B Compound	620	34	1.10	2.25
2 Device Inventive	619	33	1.11	1.35
1C Compound	642	40	1.00	1.00
2 Compound			1.00	2

[0328] Table 2 summarizes performance of electroluminescence devices. The inventive device

(device 1) using the inventive compound as the emissive dopant showed saturated red color ($\lambda_{\text{max}}=623$ nm) and narrower emission spectrum (FWHM=37 nm) compared to the device 2 using the comparative compound ($\lambda_{\text{max}}=642$ nm & FWHM=40 nm). Inventive Devices (device 1B and 1C) both showed similar results as the device 1. In general, it has been a long-sought goal to achieve the narrow FWHM. The narrower FWHM, the better color purity for the display application. As the background information, the ideal line shape is a single wavelength (single line). In the past of the OLED research, narrowing lineshape has been slowly achieved nanometer by nanometer. As can be seen here, the current inventive compounds improved the FWHM number quite significantly. In addition, devices 1, 1B, and 1C all gave higher EQE and much higher LE at 10 mA/cm² than the device 2. All these numbers are beyond any value that could be attributed to experimental error and the observed improvements are significant and unexpected. As a result, the inventive compounds can be used as emissive dopant to improve OLED device performance.

Claims

1. A compound comprising a first ligand L.sub.A of Formula I, ##STR00570## wherein: moiety C is a monocyclic ring or fused polycyclic system, where the monocyclic ring and each ring of the fused polycyclic system is independently a 5-membered and 6-membered carbocyclic or heterocyclic ring; each of X¹ to X⁶ is independently C or N; K is selected from the group consisting of a direct bond, O, S, N(R^α), P(R^α), B(R^α), C(R^α)(R^β), and Si(R^α)(R^β); at least one of R^B or R^C has the formula -L-SiR¹R²R³, or -L-GeR¹R²R³; L is a direct bond or an organic linker; R^A, R^B, and R^C each independently represents mono to the maximum allowable substitution, or no substitution; each R^α, R^β, R¹, R², R³, R^A, R^B, and R^C is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; with the proviso that R^A and R^B do not join to form a ring, any two substituents may be joined or fused to form a ring; L.sub.A is coordinated to a metal M by the dashed lines in Formula I; M has an atomic mass of at least 40 and can be coordinated to other ligands; and L.sub.A can be joined with other ligands to comprise a tridentate, tetradentate, pentadentate, or hexadentate ligand, with a proviso that if M is Ir and K is a direct bond, and moiety C is a benzene ring, then at least one of the following statements is true: (1) at least one of X¹ to X⁶ is N; (2) L is not a direct bond; (3) two R^A substituents do not join to form a ring; (4) two R^A substituents are joined together to form a structure of Formula II fused to ring A, wherein Formula II has the structure ##STR00571## wherein: Y¹ is selected from the group consisting of BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO², CR, CRR', SiRR', GeRR'; Y² is CR^{1'} or N; each R, R', R¹, R^{1'}, R², and R³ is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; and if Y² is CR^{1'}, then R is not a cyclic group or R and R' are joined together to form a fused ring.

2. The compound of claim 1, wherein each R, R', R^α, R^β, R¹, R², R³, R^A, R^B, and R^C is independently hydrogen or a substituent selected from the group consisting of deuterium, fluorine, alkyl, cycloalkyl, heteroalkyl, alkoxy, aryloxy, amino, silyl, germyl, boryl, alkenyl, cycloalkenyl, heteroalkenyl, aryl, heteroaryl, nitrile, isonitrile, sulfanyl, and combinations thereof.

3. The compound of claim 1, wherein each of X^{sup.1} to X^{sup.6} is C or at least one of X^{sup.1} to X^{sup.6} is N; and/or wherein no two substituents R^{sup.A} form a ring.

4. The compound of claim 1, wherein at least one R^{sup.A} is selected from the group consisting of alkyl, cycloalkyl, aryl, heteroaryl, partially or fully deuterated variants thereof, partially or fully fluorinated variants thereof, and combinations thereof; and/or wherein at least one R^{sup.B} has the formula -L-SiR_{sub.1}R_{sub.2}R_{sub.3}; and/or wherein L is a direct bond, alkyl, aryl, heteroaryl, or combinations thereof; and/or wherein K is a direct bond or O.

5. The compound of claim 1, wherein two R^{sup.A} substituents are joined together to form a structure of Formula II fused to ring A; and/or wherein Y^{sup.1} is bonded to X^{sup.4} and Y^{sup.2} is bonded to X^{sup.3} or wherein Y^{sup.2} is bonded to X^{sup.4} and Y^{sup.1} is bonded to X^{sup.3}; and/or wherein Y^{sup.1} is O, Se, or S; and/or wherein Y^{sup.2} is CR^{sup.1'}; and/or wherein R^{sup.1'} is joined with R to form a fused ring.

6. The compound of claim 1, wherein each of R_{sub.1}, R_{sub.2}, and R_{sub.3} is independently selected from the group consisting of alkyl, cycloalkyl, aryl, heteroaryl, silyl, and combinations thereof.

7. The compound of claim 1, wherein moiety C is selected from the group consisting of benzene, pyridine, pyrimidine, pyridazine, pyrazine, triazine, imidazole, pyrazole, pyrrole, oxazole, furan, thiophene, thiazole, naphthalene, quinoline, isoquinoline, quinazoline, benzofuran, aza-benzofuran, benzoxazole, aza-benzoxazole, benzothiophene, aza-benzothiophene, benzothiazole, aza-benzothiazole, benzoselenophene, aza-benzoselenophene, indene, aza-indene, indole, aza-indole, benzimidazole, aza-benzimidazole, carbazole, aza-carbazole, dibenzofuran, aza-dibenzofuran, dibenzothiophene, aza-dibenzothiophene, quinoxaline, phthalazine, phenanthrene, aza-phenanthrene, anthracene, aza-anthracene, phenanthridine, fluorene, and aza-fluorene.

8. The compound of claim 1, wherein the ligand L_{sub.A} is selected from the group consisting of the structures of LIST 1 defined herein; wherein each of X^{sup.7} to X^{sup.16} is independently C or N; W is selected from B, N, CR, SiR, GeR, or P; each of Y^{sup.A1}, Y^{sup.A2}, and Z_{sub.1} is independently selected from the group consisting of BR_{sub.e}, BR_{sub.e}R_{sub.f}, NR_{sub.e}, PR_{sub.e}, P(O) R_{sub.e}, O, S, Se, C=O, C=S, C=Se, C=NR_{sub.e}, C=CR_{sub.e}R_{sub.f}, S=O, SO_{sub.2}, CR_{sub.e}, CR_{sub.e}R_{sub.f}, SiR_{sub.e}R_{sub.f}, and GeR_{sub.e}R_{sub.f}; each R^{sup.AA} independently represents mono to the maximum allowable substitution, or no substitution; each R^{sup.e}, R_{sub.f}, and R^{sup.AA} is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; and any two substituents can be joined or fused to form a ring.

9. The compound of claim 1, wherein the ligand L_{sub.A} is selected from the group consisting of the structures of LIST 2 defined herein; wherein: each of Y^{sup.A1}, Y^{sup.A2}, and Y^{sup.B1} is independently selected from the group consisting of BR_{sub.e}, BR_{sub.e}R_{sub.f}, NR_{sup.e}, PR_{sub.e}, P(O) R_{sub.e}, O, S, Se, C=O, C=S, C=Se, C=NR_{sub.e}, C=CR_{sub.e}R_{sub.f}, S=O, SO_{sub.2}, CR_{sub.e}, CR_{sub.e}R_{sub.f}, SiR_{sub.e}R_{sub.f}, and GeR_{sub.e}R_{sub.f}; each R^{sup.AA} and R^{sup.CC} independently represents mono to the maximum allowable substitution, or no substitution; each R^{sup.AA}, R^{sup.CC}, R_{sub.e}, and R_{sub.f} is independently hydrogen or a substituent selected from the group consisting of deuterium, halogen, alkyl, cycloalkyl, heteroalkyl, heterocycloalkyl, boryl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carboxylic acid, ether, ester, nitrile, isonitrile, sulfanyl, sulfinyl, sulfonyl, phosphino, selenyl, and combinations thereof; and any two substituents can be joined or fused to form a ring.

10. The compound of claim 1, the ligand L_{sub.A} is selected from the group consisting of L_{sub.A-w}-(R^{sup.EA})(R^{sup.EB})(R^{sup.EC})(R^{sup.ED})(R^{sup.EE})(R_{sub.Z}) wherein w is an integer from

41 to 80, each of R.sub.EA, R.sub.EB, R.sub.EC, R.sub.ED, and R.sub.EE is independently selected from the group consisting of R.sub.1 to R.sub.337, and R.sub.Z is selected from the group consisting of R.sub.Z1 to R.sub.Z141; wherein each of L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144), are defined in LIST 3a defined herein; wherein R.sub.1 to R.sub.337 are defined in LIST 4a defined herein.

11. The compound of claim 1, wherein the compound has a formula of $M(L.sub.A).sub.p(L.sub.B).sub.q(L.sub.C).sub.r$ wherein L.sub.B and L.sub.C are each a bidentate ligand; and wherein p is 1, 2, or 3; q is 0, 1, or 2; r is 0, 1, or 2; and p+q+r is the oxidation state of the metal M.

12. The compound of claim 11, wherein the compound has a formula selected from the group consisting of $Ir(L.sub.A).sub.3$, $Ir(L.sub.A)(L.sub.B).sub.2$, $Ir(L.sub.A).sub.2(L.sub.B)$, $Ir(L.sub.A).sub.2(L.sub.C)$, and $Ir(L.sub.A)(L.sub.B)(L.sub.C)$; and wherein L.sub.A, L.sub.B, and L.sub.C are different from each other or a formula of $Pt(L.sub.A)(L.sub.B)$; and wherein L.sub.A and L.sub.B can be same or different.

13. The compound of claim 11, wherein L.sub.B and L.sub.C are each independently selected from the group consisting of the structures of LIST 6 defined herein; wherein: T is selected from the group consisting of B, Al, Ga, and In; K.sup.1' is selected from the group consisting of a single bond, O, S, NR.sub.e, PR.sub.e, BR.sub.e, CR.sub.eR.sub.f, and SiR.sub.eR.sub.f; each of Y.sup.1 to Y.sup.13 is independently selected from the group consisting of C and N; Y' is selected from the group consisting of BR.sub.e, BR.sub.eR.sub.f, NR.sub.e, PR.sub.e, P(O)R.sub.e, O, S, Se, C=O, C=S, C=Se, C=NR.sub.e, C=CR.sub.eR.sub.f, S=O, SO.sub.2, CR.sub.eR.sub.f, SiR.sub.eR.sub.f, and GeR.sub.eR.sub.f; R.sub.e and R.sub.f can be fused or joined to form a ring; each R.sub.a, R.sub.b, R.sub.c, and R.sub.d independently represents from mono to the maximum allowed number of substitutions, or no substitution; each of R.sub.a1, R.sub.b1, R.sub.c1, R.sub.d1, R.sub.a, R.sub.b, R.sub.c, R.sub.d, R.sub.e, and R.sub.f is independently a hydrogen or a substituent selected from the group consisting of deuterium, halide, alkyl, cycloalkyl, heteroalkyl, arylalkyl, alkoxy, aryloxy, amino, silyl, germyl, boryl, alkenyl, cycloalkenyl, heteroalkenyl, alkynyl, aryl, heteroaryl, acyl, carbonyl, carboxylic acid, ester, nitrile, isonitrile, sulfanyl, selenyl, sulfinyl, sulfonyl, phosphino, and combinations thereof; and any two substituents of R.sub.a1, R.sub.b1, R.sub.c1, R.sub.d1, R.sub.a, R.sub.b, R.sub.c, and R.sub.d can be fused or joined to form a ring or form a multidentate ligand.

14. The compound of claim 11, wherein the compound has formula $Ir(L.sub.A).sub.3$, formula $Ir(L.sub.A)(L.sub.Bk).sub.2$, formula $Ir(L.sub.A).sub.2(L.sub.Bk)$, formula $Ir(L.sub.A).sub.2(L.sub.Cj-I)$, or formula $Ir(L.sub.A).sub.2(L.sub.Cj-II)$, wherein L.sub.A is according to Formula I, including L.sub.A-1-(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.1)(R.sup.H1) to L.sub.A-40-(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.111)(R.sup.H49) and L.sub.A-41-(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.1)(R.sub.Z1) to L.sub.A-80-(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.337)(R.sub.Z144); wherein k is an integer from 1 to 474, and each L.sub.Bk has the structure defined in LIST 8 defined herein; wherein each L.sub.Cj-I has a structure based on formula ##STR00572## and each L.sub.Cj-II has a structure based on formula ##STR00573## wherein for each L.sub.Cj in L.sub.Cj-I and L.sub.Cj-II, R.sup.201 and R.sup.202 are each independently defined in LIST 9 defined herein; wherein R.sup.D1 to R.sup.D246 have the structures defined in LIST 10 defined herein.

15. The compound of claim 1, wherein the compound is selected from the group consisting of the structures of LIST 11 defined herein.

16. The compound of claim 11, wherein the compound has the Formula III: ##STR00574## wherein: M.sup.1 is Pd or Pt; moieties E and F are each independently monocyclic or polycyclic ring structure comprising 5-membered and/or 6-membered carbocyclic or heterocyclic rings; Z.sup.1 and Z.sup.2 are each independently C or N; K, K.sup.1 and K.sup.2 are each independently

selected from the group consisting of a direct bond, O, and S, wherein at least two of them are direct bonds; L.sup.1, L.sup.2, and L.sup.3 are each independently absent or selected from the group consisting of a direct bond, BR, BRR', NR, PR, P(O)R, O, S, Se, C=O, C=S, C=Se, C=NR, C=CRR', S=O, SO.sub.2, CR, CRR', SiRR', GeRR', alkylene, cycloalkyl, aryl, cycloalkylene, arylene, heteroarylene, and combinations thereof, wherein at least one of L.sup.1 and L.sup.2 is present; R.sup.E and R.sup.F each independently represents zero, mono, or up to a maximum allowed number of substitutions; each of R, R', R.sup.E, and R.sup.F is independently a hydrogen or a substituent selected from the group consisting of deuterium, fluorine, alkyl, cycloalkyl, heteroalkyl, alkoxy, aryloxy, amino, silyl, boryl, alkenyl, cycloalkenyl, heteroalkenyl, aryl, heteroaryl, nitrile, isonitrile, sulfanyl, and combinations thereof; and any two adjacent R, R', R.sup.A, R.sup.B, R.sup.C, R.sup.E, and R.sup.F can be joined or fused together to form a ring where chemically feasible.

17. An organic light emitting device (OLED) comprising: an anode; a cathode; and an organic layer disposed between the anode and the cathode, wherein the organic layer comprises a compound according to claim 1.

18. The OLED of claim 17, wherein the organic layer further comprises a host, wherein the host comprises at least one chemical moiety selected from the group consisting of triphenylene, carbazole, indolocarbazole, dibenzothiophene, dibenzofuran, dibenzoselenophene, 5λ.sup.2-benzo[d]benzo[4,5]imidazo[3,2-a]imidazole, 5,9-dioxa-13b-boranaphtho[3,2,1-de]anthracene, triazine, boryl, silyl, aza-triphenylene, aza-carbazole, aza-indolocarbazole, aza-dibenzothiophene, aza-dibenzofuran, aza-dibenzoselenophene, aza-5λ.sup.2-benzo[d]benzo[4,5]imidazo[3,2-a]imidazole, and aza-(5,9-dioxa-13b-boranaphtho[3,2,1-de]anthracene).

19. The OLED of claim 17, wherein the organic layer further comprises a host, wherein the host is selected from the group consisting of the structures of HOST Group 1 defined herein.

20. A consumer product comprising an organic light-emitting device (OLED) comprising: an anode; a cathode; and an organic layer disposed between the anode and the cathode, wherein the organic layer comprises a compound according to claim 1.
